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# H8S/20103, H8S/20203, and H8S/20223 Groups

## Reprogramming Data-Flash Memory in EW1 Mode

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### Introduction

Data-flash areas within products of the H8S/20103, H8S/20203, and H8S/20223 Groups can be reprogrammed in EW1 mode.

### Target Devices

H8S/20103 (R4F20103)

H8S/20203 (R4F20203)

H8S/20223 (R4F20223)

### Frequency Used in Confirming Operation

System clock  $\phi = \phi_{osc} = 20$  MHz

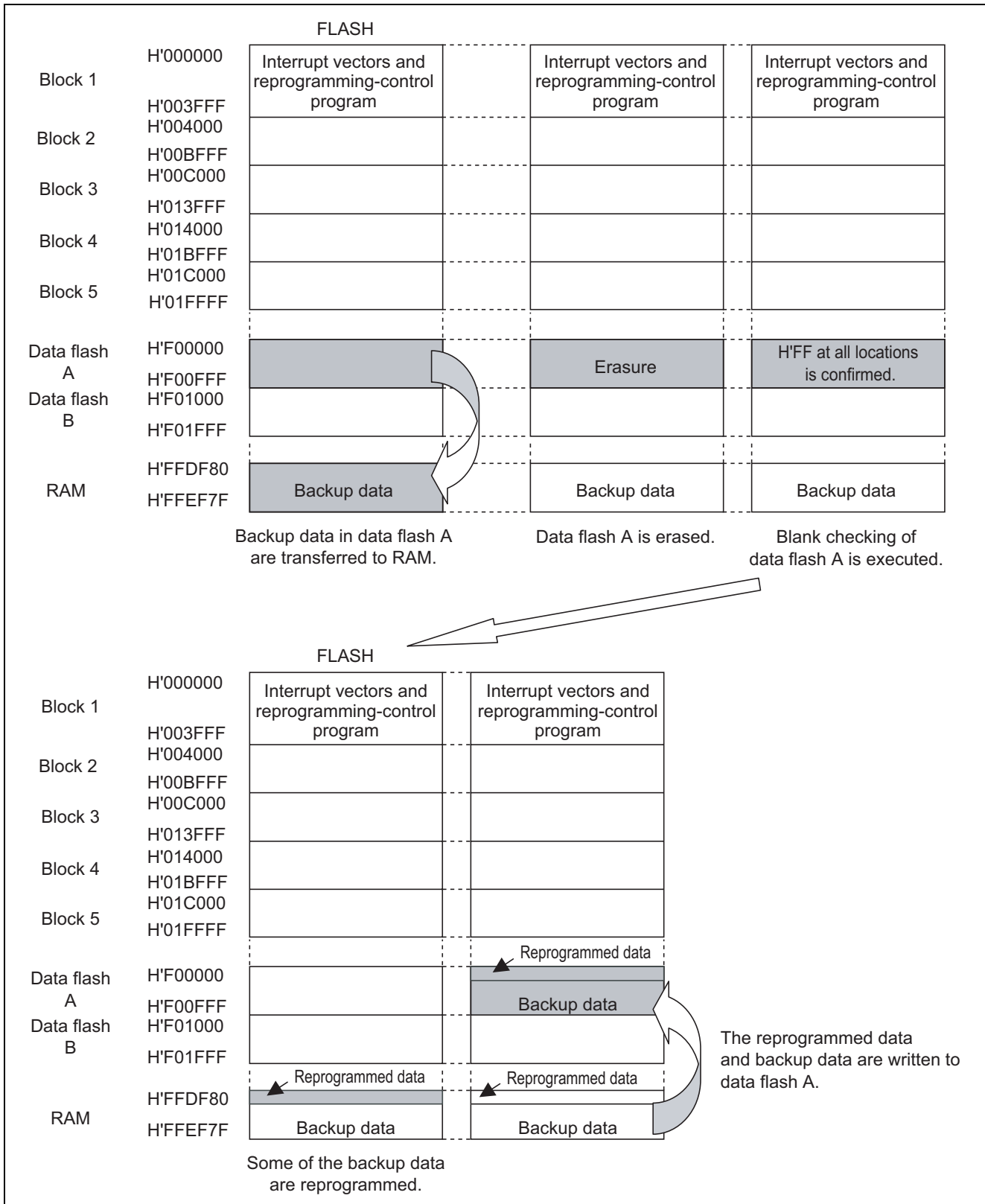
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## 1. Specifications

Specifications of this sample task are as given below. Figure 1 shows an overview of the reprogramming of data-flash memory. In this application note, the first 128 bytes in data-flash area A are reprogrammed.

- (1) The 4 Kbytes in data-flash area A are backed up by being transferred to a RAM area.
- (2) Data-flash area A is erased.
- (3) Blank checking is executed for data-flash area A.
- (4) Data in the first 128 bytes of the RAM area where the back-up was made are reprogrammed.
- (5) After reprogramming, the 4-Kbytes that have been backed-up in the RAM area are written to data-flash area A.
- (6) Steps 1 to 5 accomplish reprogramming of the first 128 bytes of data-flash area A.



**Figure 1 Overview of Reprogramming the Data Flash in EW1 Mode**

## 2. Description of Module Used

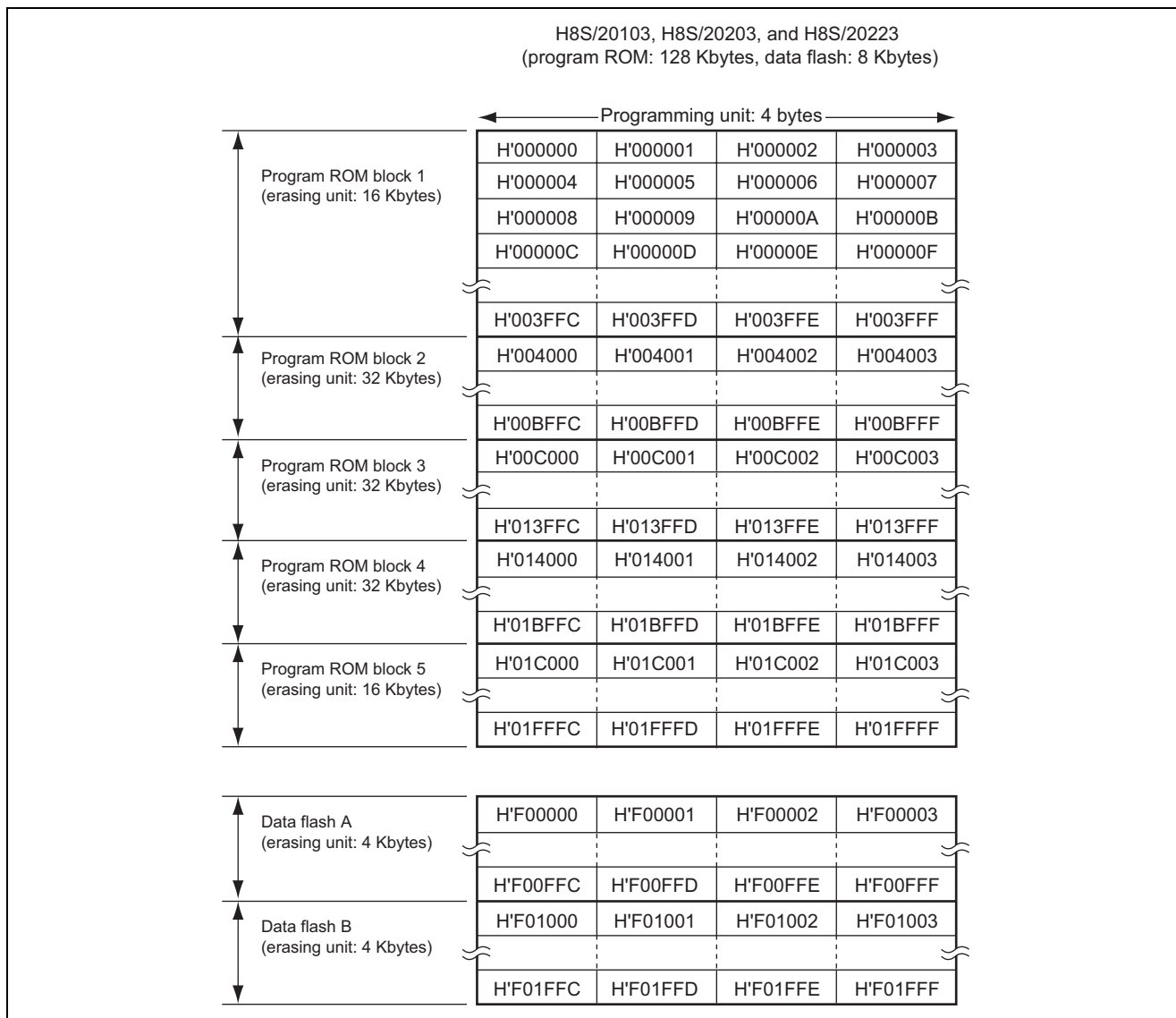
### 2.1 ROM

The features of the on-chip flash memory are described below.

- Programming/erasing method  
Four bytes are programmed simultaneously. A single block is erased at a time; only one block should be erased at a time even when the entire ROM area is to be erased.
- Programming/erasing time  
Program ROM programming time: 150  $\mu$ s (typ.) for 4-byte simultaneous programming, i.e., 38  $\mu$ s (typ.) per byte  
Data-flash programming time: 300  $\mu$ s (typ.) for 4-byte simultaneous programming, i.e., 75  $\mu$ s (typ.) per byte  
Erasing time: 200 ms (typ.) per block for the program ROM and data-flash areas.
- Reprogramming capability  
The program ROM area can be reprogrammed up to 1,000 times and the data-flash area can be reprogrammed up to 10,000 times.
- Two on-board programming modes  
Boot mode: The on-chip SCI can be used for programming/erasing the user ROM area. In this mode, the communications bit rate between the host and this LSI can be automatically adjusted.  
User mode: Any interface can be used for programming/erasing the user ROM area.
- Programmer mode  
A PROM programmer is used for programming/erasing.
- Protection function  
Flash memory can be protected against erroneous programming and erasure.  
Lock-bit protection function can be set through software.
- PROM-programmer protection/Boot-mode protection  
By writing specified data to a specified address range in user ROM, protection of the user-ROM area in boot mode and PROM-programmer mode can be established.
- Access cycle  
Program ROM: One state  
Data flash: Two states

### 2.1.1 Block Configuration

Figure 2 shows the blocks of the flash memory. The user ROM area contains the program ROM area for storing the microcomputer's operating program and the data-flash area for storing data. In the figure, each thick-line frame indicates an erasure block (erasing unit); each thin-line frame indicates a programming unit. The values in the frames are addresses. Erasure is done in units of the erasure blocks shown in figure 2. Programming is done in 2-word (4-byte) units at addresses with the lower-order four-bit values H'0, H'4, H'8, or H'C.



**Figure 2 Block Configuration of Flash Memory**

### 2.1.2 CPU Reprogramming Mode

In CPU reprogramming mode, the user ROM area can be reprogrammed by executing the software commands by the CPU. The software commands should be issued to the specific area to be reprogrammed in the user ROM area.

If an interrupt is requested during erasure operation in CPU reprogramming mode, erasure can be suspended to process the interrupt. This is referred to as erase-suspend function. In erase-suspend mode, the user ROM area can be read through programming.

CPU reprogramming is performed in either of two modes, EW0 mode and EW1 mode. Table 1 shows differences between the two modes.

**Table 1 Differences between EW0 Mode and EW1 Mode**

Item	EW0 Mode	EW1 Mode
Area in which a reprogramming-control program can be located	User ROM area	
Area in which a reprogramming-control program can be executed	A reprogramming-control program must be transferred to RAM before execution.	A reprogramming-control program can be executed in the user ROM area.
Area which can be reprogrammed	User ROM area	User ROM area excluding the blocks in which a reprogramming-control program is located.
Limitations on software commands	None	The program and erasure commands must not be executed on any block in which a reprogramming-control program is located.
Mode after software command execution	Read-array mode	
CPU state during auto-programming and auto-erasure	Operating state	Hold state (I/O ports retain the states in which they have been before the command is executed.)
Flash memory state detection	Read the FMPSRF, FMERSF, and FMEBSF bits in FLMSTR in a program.	
Conditions of transition to erase-suspend state	Both the FMSPEN and FMSPREQ bits in FLMCR2 are set to 1. Or, both the FMSPEN and FMISPE bits in FLMCR2 are set to 1 and an interrupt is requested.	The FMSPEN bit in FLMCR2 is set to 1 and an interrupt is requested.
Conditions of Interrupt generation	<ul style="list-style-type: none"> <li>The flash memory returns from the busy state to the ready state*<sup>1</sup>.</li> <li>The user ROM area is read in the busy state*<sup>1</sup>.</li> </ul>	Use of interrupts is prohibited.
Usage of DTC	Usable* <sup>2</sup>	Usable* <sup>2</sup> * <sup>3</sup>

Notes: 1. To avoid the generation of access to the user ROM area, set VOFR so that the variable vectors and interrupt processing routines are allocated to RAM.

2. Allocate DTC vectors and processing routines to RAM. Do not use the DTC for access to the user ROM area during E/W processing. If this is ignored, values read will be invalid.

3. Do not use the DTC if the reprogramming-control program is allocated to RAM.

### **2.1.3 EW0 Mode**

EW0 mode can be selected by transferring the reprogramming-control program to the RAM, branching to the program in the RAM, setting the FMEWMOD bit in FLMCR1 to 0, and setting the FMCMDEN bit in FLMCR1 to 1 (to enable software commands), in this order.

Programming and erasure operations can be controlled through software commands. Completion of the software command and related information can be read out from the FLMSTR register.

To cause a transition to erase-suspend mode during erasure, set both the FMSPEN and FMSPREQ bits in FLMCR2 to 1 (to enable a transition to erase-suspend mode and to request a transition to erase-suspend mode, respectively). Then wait for the transition time to erase-suspend mode (approximately 50  $\mu$ s), check that the FMRDY bit in FLMSTR is 1 (ready state), and access the user ROM area. Setting the FMSPREQ bit to 0 resumes erasure.

When the interrupt is used, set the interrupt vector offset register (VOFR) such that access to the user ROM area is not generated. That is, the vectors should be at addresses within the RAM and point to interrupt processing routines that are also in the RAM.

### **2.1.4 EW1 Mode**

EW1 mode can be selected by setting the FMEWMOD bit in FLMCR1 to 1, and then setting the FMCMDEN bit in FLMCR1 to 1 (to enable software commands).

Programming and erasure operations can be controlled through software commands. Completion of the software command and related information can be read out from the FLMSTR register.

To cause a transition to erase-suspend mode during erasure, set the FMSPEN bit in FLMCR2 to 1 (to enable a transition to erase-suspend mode), and then execute the erasure command. Note that the interrupt for causing a transition to erase-suspend mode must be enabled beforehand. This allows the interrupt request to be accepted when the transition time to erase-suspend mode has elapsed after the erasure command is executed.

When an interrupt is requested, the FMSPREQ bit is automatically set to 1 (to request a transition to erase-suspend mode), thus suspending erasure. If erasure has not been completed at the end of interrupt processing (FMERCF = 1 in FLMSTR), resume erasure by setting the FMSPREQ bit to 0.

### 2.1.5 Programming/Erasing

In what is termed CPU reprogramming, the CPU executes software commands to program and erase flash memory on board.

### 2.1.6 Software Commands

Table 2 shows a list of the software commands with word-length instructions and table 3 shows a list of the software commands with byte-length instructions. Whether an instruction is to be byte-length or word-length is specified by the FMWUS bit in FLMCR1.

**Table 2 Software Commands (Word Length: FMWUS = 1)**

Software Command	First Command Cycle			Second Command Cycle			Third Command Cycle			Command Use in Modes	
	Mode	Addr.	Data	Mode	Addr.	Data	Mode	Addr.	Data	EW0	EW1
Erasure	Write	×	H'2020	Write	BA	H'D0D0				Possible	Possible
Programming	Write	WA	H'4141	Write	WA	WD1	Write	WA	WD2	Possible	Possible
Blank checking	Write	×	H'2525	Write	BA	H'D0D0				Possible	Possible
Lock-bit programming	Write	×	H'7777	Write	BA	H'D0D0				Possible	Possible
Read-array	Write	×	H'FFFF							Possible	—
Clear-status	Write	×	H'5050							Possible	Possible
Lock-bit reading	Write	×	H'7171	Read	BA	H'xxxx				Possible	Impossible

- [Legend]
- ×: Arbitrary address in the user ROM area
  - xx: Eight-bit arbitrary data
  - BA: Arbitrary address in the target block
  - WA: Programming address. (The lower two bits of an address are ignored. WA should be the same in each command cycle.)
  - WDn: Programming data (16 bits)

**Table 3 Software Commands (Byte Length: FMWUS = 0)**

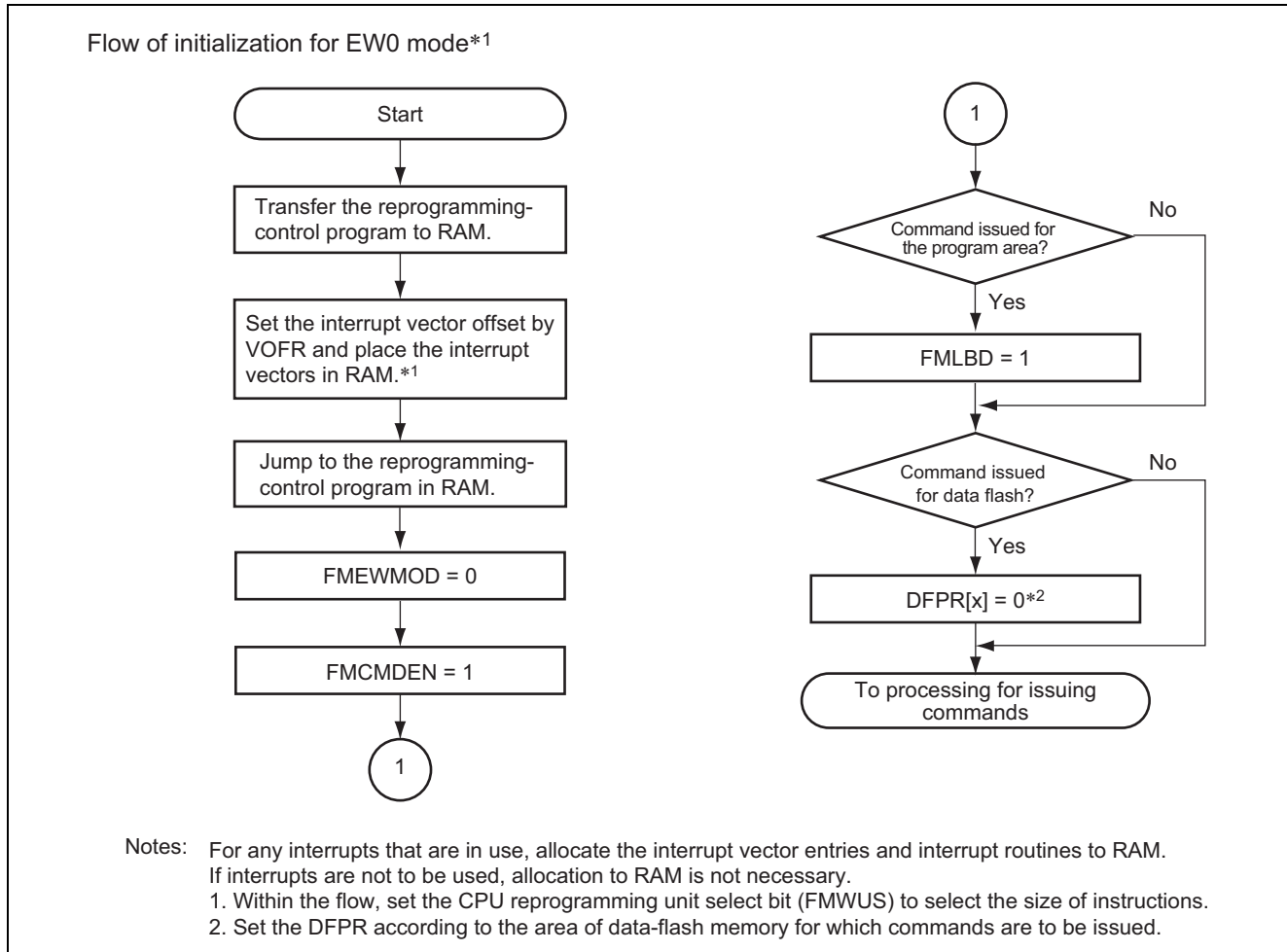
Software Command	First Command Cycle			Second Command Cycle			Third Command to Fifth Command Cycle			Command Use in Modes	
	Mode	Addr.	Data	Mode	Addr.	Data	Mode	Addr.	Data	EW0	EW1
Erasure	Write	×	H'20	Write	BA	H'D0				Possible	Possible
Programming	Write	WA	H'41	Write	WA	WD1	Write	WA	WD2 to WD4	Possible	Possible
Blank checking	Write	×	H'25	Write	BA	H'D0				Possible	Possible
Lock-bit programming	Write	×	H'77	Write	BA	H'D0				Possible	Possible
Read-array	Write	×	H'FF							Possible	—
Clear-status	Write	×	H'50							Possible	Possible
Lock-bit reading	Write	×	H'71	Read	BA	H'xx				Possible	Impossible

[Legend] ×: Arbitrary address in the user ROM area  
 xx: Eight-bit arbitrary data  
 BA: Arbitrary address at the target block  
 WA: Programming address. (The lower two bits of an address are ignored. WA should be the same in each command cycle.)  
 WDn: Programming data (8 bits)

### (1) Initialization for CPU Reprogramming

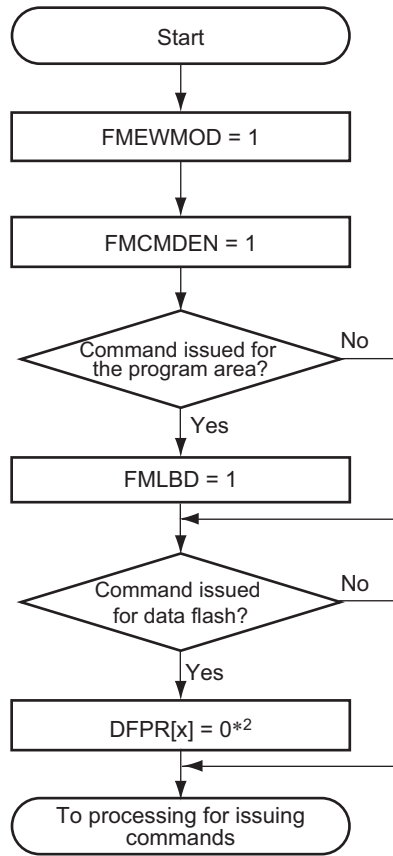
Before software commands are issued, settings for CPU reprogramming mode must be made and issuing of software commands must be permitted.

Figures 3 and 4 show initialization for CPU reprogramming mode.



**Figure 3 Initialization for EW0 Mode**

Flow of initialization for EW1 mode\*1



- Notes: For any interrupts that are in use, allocate the interrupt vector entries and interrupt routines to RAM. If interrupts are not to be used, allocation to RAM is not necessary.
1. Within the flow, set the CPU reprogramming unit select bit (FMWUS) to select the unit of overwriting.
  2. Set the DFPR according to the area of data-flash memory for which commands are to be issued.

Figure 4 Initialization for EW1 Mode

### (2) Erasure

When H'20 is written in the first command cycle and H'D0 is written to any address in the block in the second command cycle, erase/erase-verify of the specified block is automatically started.

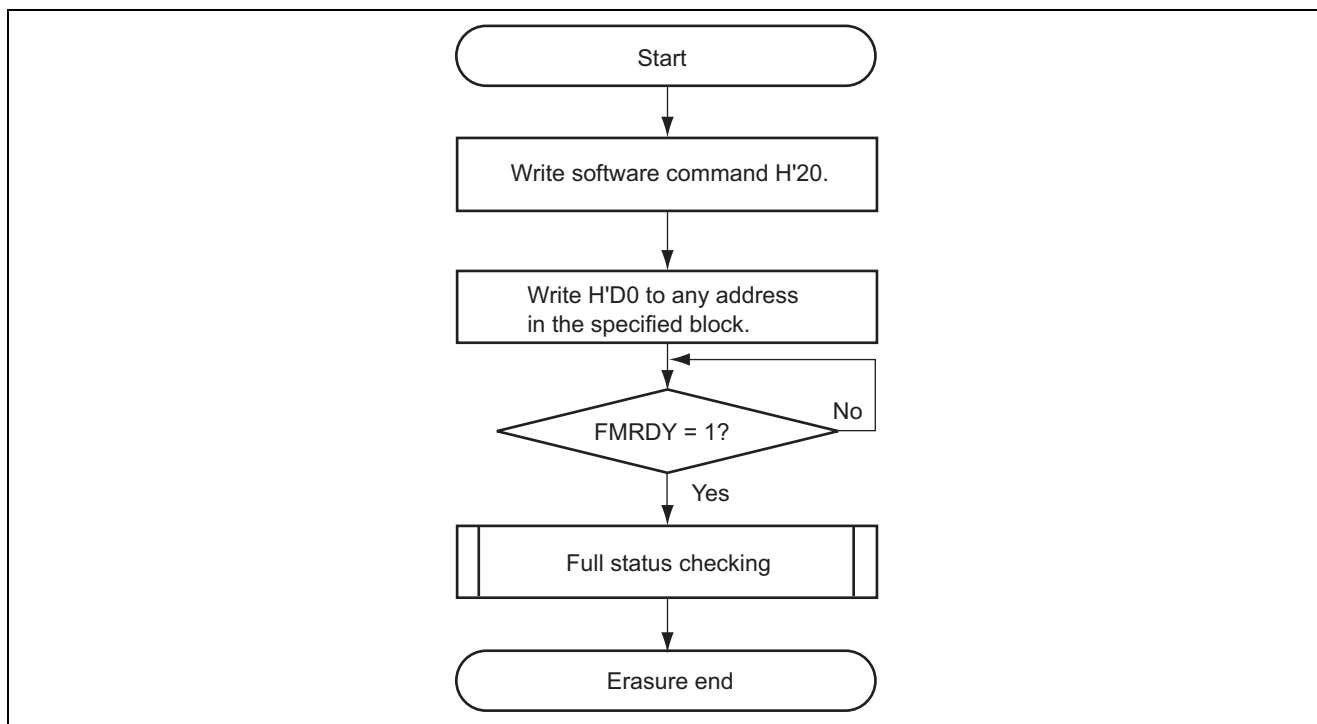
Completion of erasure is indicated by the FMRDY bit in FLMSTR. The FMRDY bit is read as 0 during erasure, and read as 1 after erasure has been completed.

When erasure has been completed, the erasure result can be checked by reading the FMEBSF bit in FLMSTR. (See the description in (9) below, Full Status Checking.)

Note that if the lock bit is 0 (locked) in the specified block and the FMLBE bit is 0 (lock bit enabled), an erasure command is not accepted for the specified block. Figure 5 to 7 are flowcharts of erasure, with figure 5 depicting the case where the erase-suspend function is not in use and figures 6 and 7 depicting the cases where it is in use.

When the erase-suspend function is being employed and erasure is resumed immediately after a period in erase-suspend mode, instruction fetching with normal incrementation of the program counter will not be possible. To avoid this problem, add two NOP instructions immediately after the instruction that writes FMSPREQ = 0. Furthermore, do not use the DTC when erasure has been suspended in EW1 mode and the reprogramming control program has been allocated to RAM.

In EW1 mode, do not execute this command for the block in which the reprogramming-control program is located. The FMRDY bit in FLMSTR changes to 0 when erasure is started, and changes to 1 when completed.



**Figure 5 Flowchart of Erasure When the Erase-Suspend Function is Not in Use**

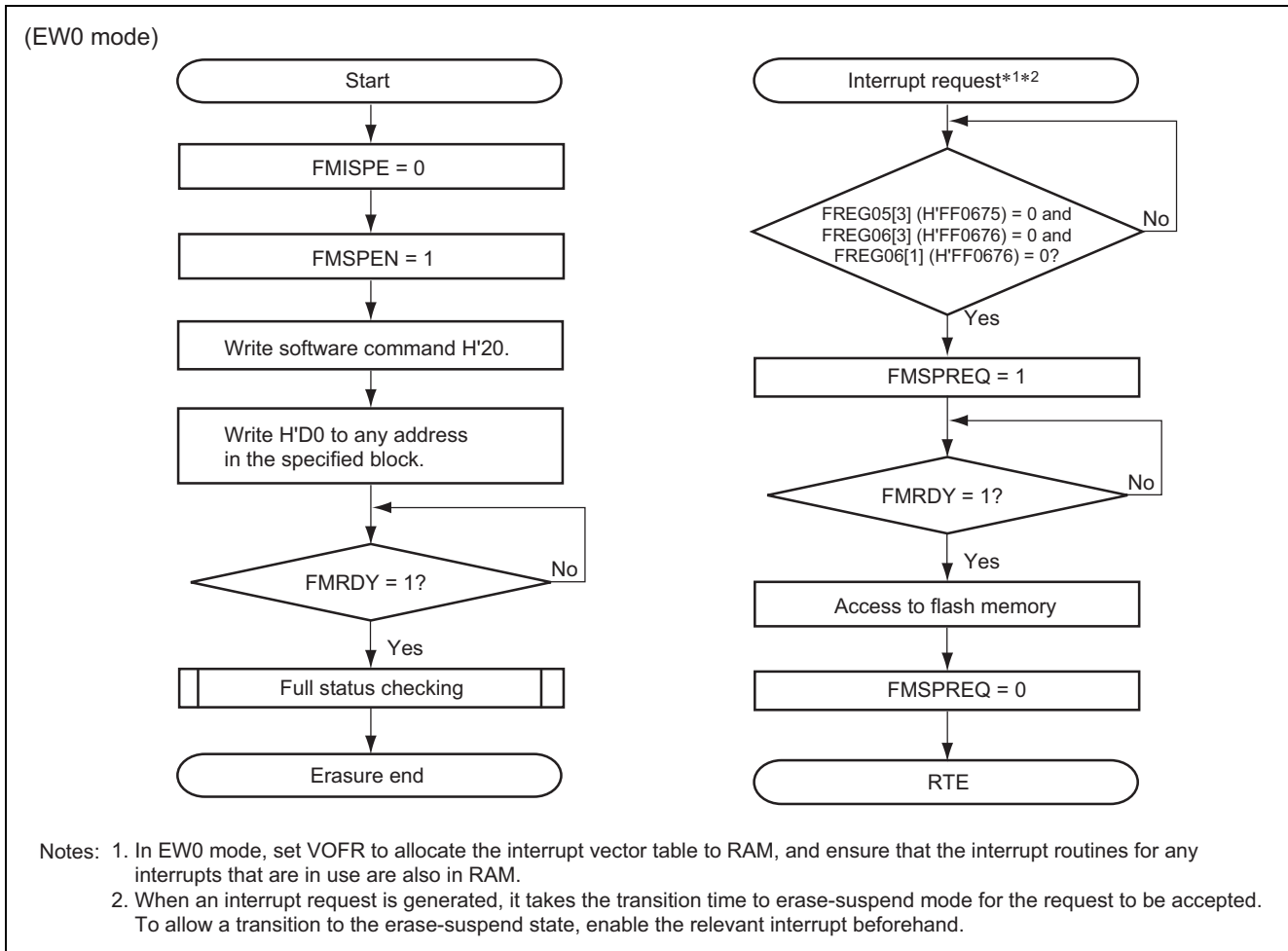
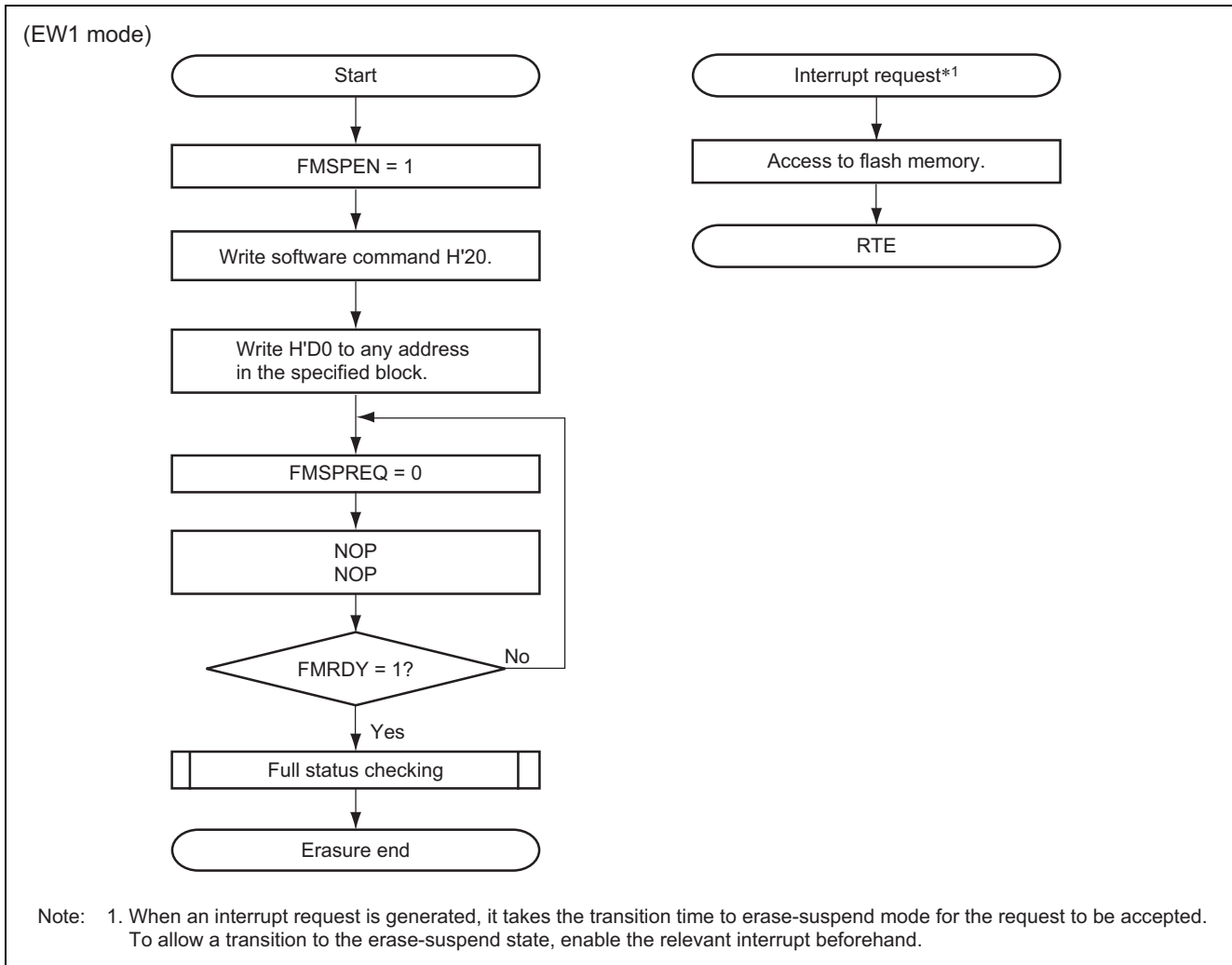


Figure 6 Flowchart of Erasure in EW0 Mode When the Erase-Suspend Function is in Use



**Figure 7 Flowchart of Erasure in EW1 Mode When the Erase-Suspend Function is in Use**

### (3) Programming

A program command is used to program data in flash memory in 4-byte units.

Command or data size can be set depending on the FMWUS bit in FLMCR1. Setting the FMWUS bit to 0 enables using byte-length instructions. When H'41 is written in the first command cycle and data are written to the programming address in the second through fifth command cycles, programming and verifying are automatically started\*.

Setting the FMWUS bit to 1 enables using word-length instructions. When H'4141 is written in the first command cycle and data are written to the programming address in the second and third command cycles, programming and verifying are started\*.

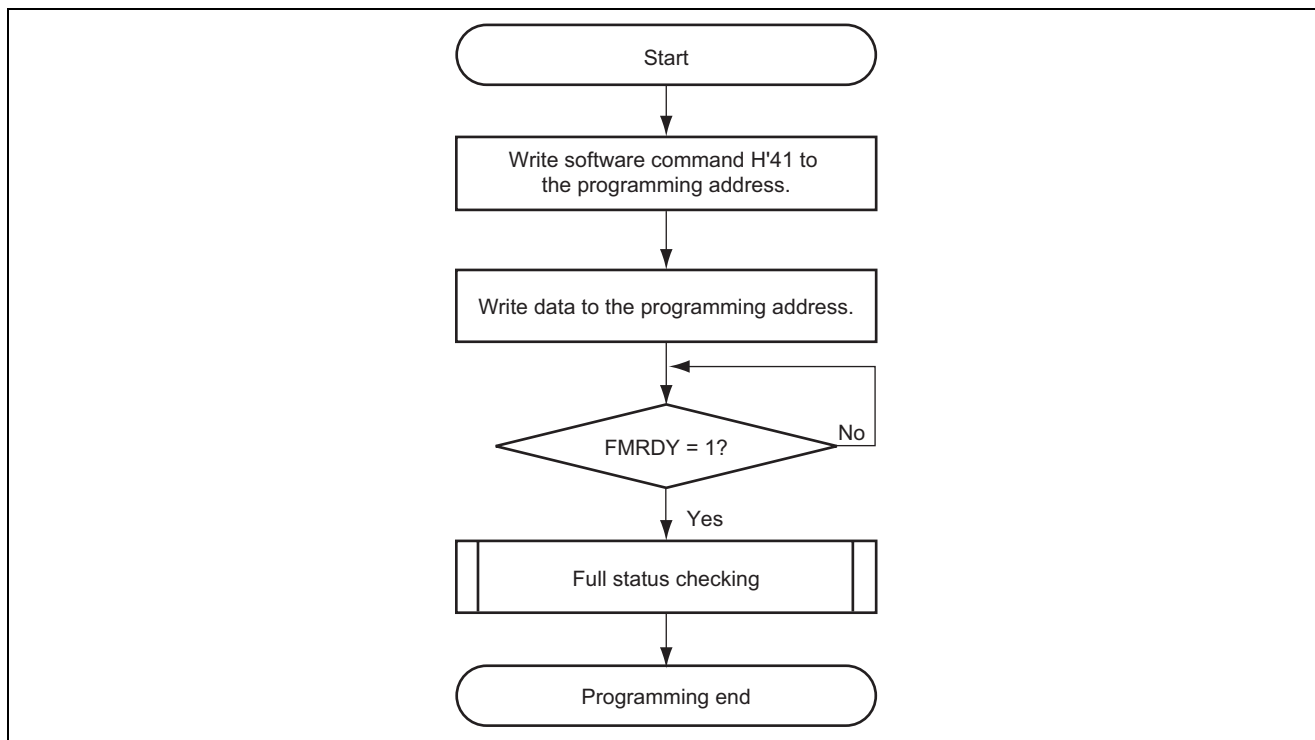
Completion of programming is indicated by the FMRDY bit in FLMSTR. The FMRDY bit is read as 0 during programming, and as 1 once programming has been completed.

When programming has been completed, the results of programming can be checked by reading the FMPRSF bit in FLMSTR (see the description under (9), Full Status Checking below). Figure 8 shows the programming flowchart. Do not attempt further programming at addresses that have already been programmed.

Note that if the lock bit is 0 (locked) in the specified block and the FMLBD bit is 0 (lock bit enabled), a programming command is not accepted for the specified block.

In EW1 mode, do not execute this command for the block in which the reprogramming-control program is located. The FMRDY bit in FLMSTR changes to 0 when programming is started, and changes to 1 when completed.

Note: \* The lower two bits of the programming addresses are ignored.



**Figure 8 Programming Flowchart**

### (4) Blank Checking

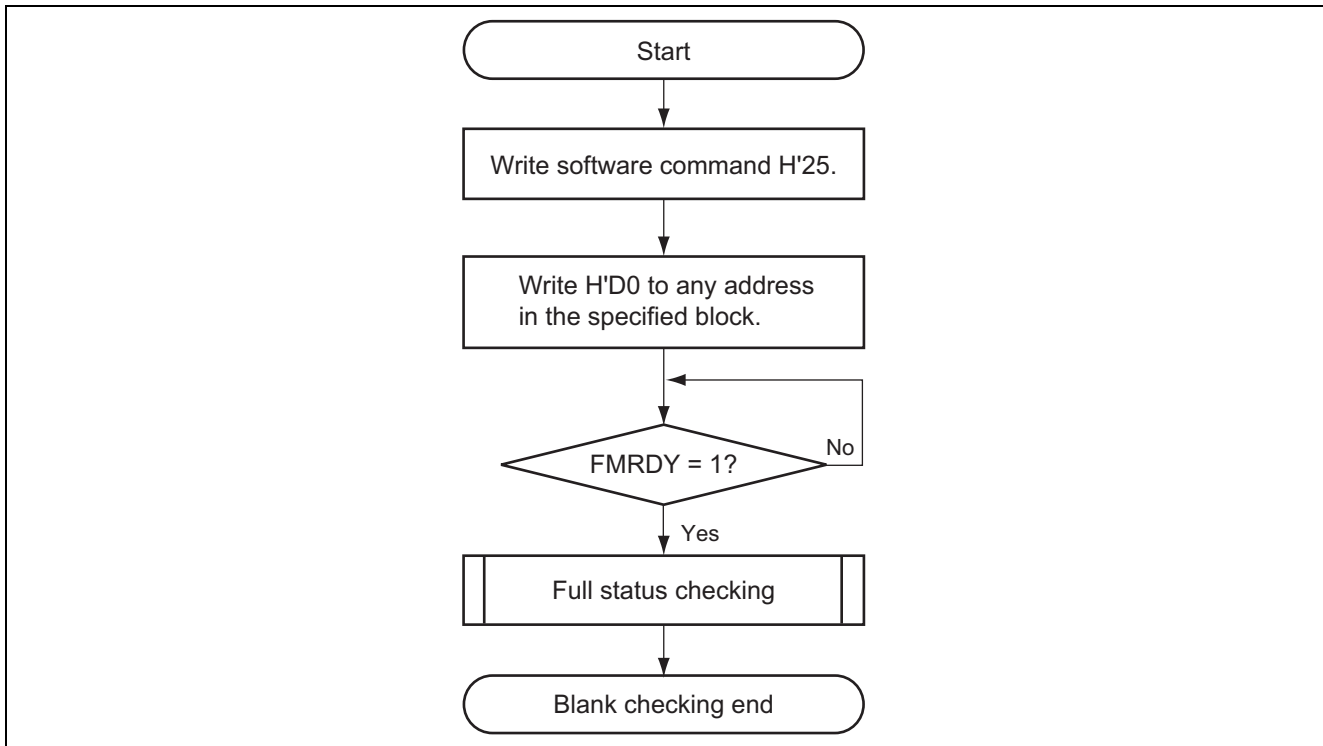
When H'25 is written in the first command cycle and H'D0 is written to any address in the block in the second command cycle, blank checking of the specified block is started.

Completion of blank checking is indicated by the FMRDY bit in FLMSTR. The FMRDY bit is read as 0 during blank checking, and read as 1 after blank checking has been completed.

When blank checking has been completed, the results of blank checking can be checked by reading the FMEBSF bit in FLMSTR (see the description under (9), Full Status Checking below).

Figure 9 shows the blank checking flowchart.

The FMRDY bit in FLMSTR changes to 0 when blank checking is started, and changes to 1 when completed.



**Figure 9 Blank Checking Flowchart**

(5) Lock-Bit Programming

When H'77 is written in the first command cycle and H'D0 is written to any address in the block in the second command cycle, lock-bit programming of the specified block is started.

Completion of lock-bit programming is indicated by the FMRDY bit in FLMSTR. The FMRDY bit is read as 0 during lock-bit programming, and read as 1 after lock-bit programming has been completed.

When lock-bit programming has been completed, the lock-bit programming result can be checked by reading the FMPSF bit in FLMSTR (see the description under (9), Full Status Checking below).

Figure 10 shows the lock-bit programming flowchart.

The FMRDY bit in FLMSTR changes to 0 when lock-bit programming is started, and changes to 1 when completed.

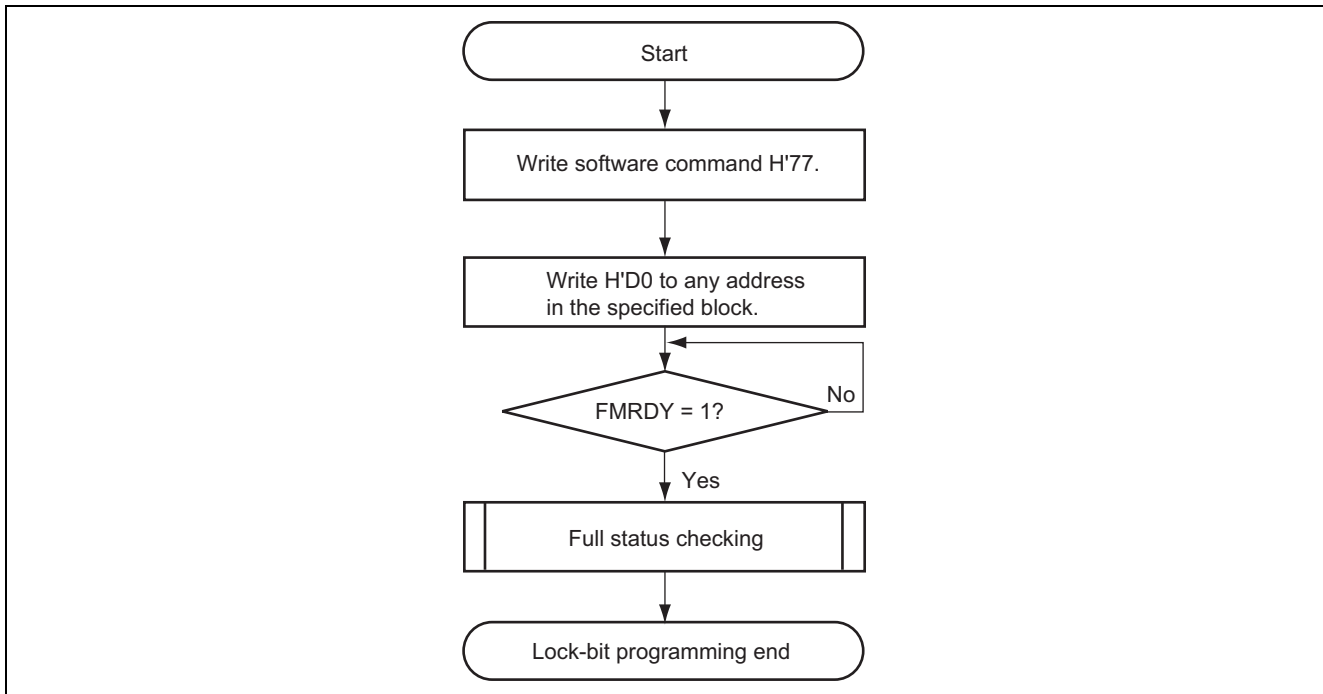


Figure 10 Lock-Bit Programming Flowchart

**(6) Read-Array Command**

A read-array command is to cause a transition to a mode in which data can be read from flash memory.

When H'FF is written in the first command cycle, a transition to read array mode is caused. When the specified addresses are read out in the subsequent command cycles, data are read from the specified addresses.

Since read-array mode is retained until any other command is written, multiple addresses can be read successively.

**(7) Lock-Bit Reading Command**

A lock-bit reading command is to cause a transition to a mode in which the lock bit in flash memory can be read.

When H'71 is written in the first command cycle and H'D0 is written to any address in the block in the second command cycle, lock-bit reading of the specified block is started.

After transition to lock-bit read mode, reading the specified block address BA returns the lock-bit value in the bit 14 value to be read. Do not execute a lock-bit read command in the ROM.

**(8) Status Clearing Command**

A clear-status command is used to clear the status flag to 0.

When H'50 is written in the first command cycle, the FMPRSF and FMEBSF bits in FLMSTR are cleared to 0.

**(9) Full Status Checking**

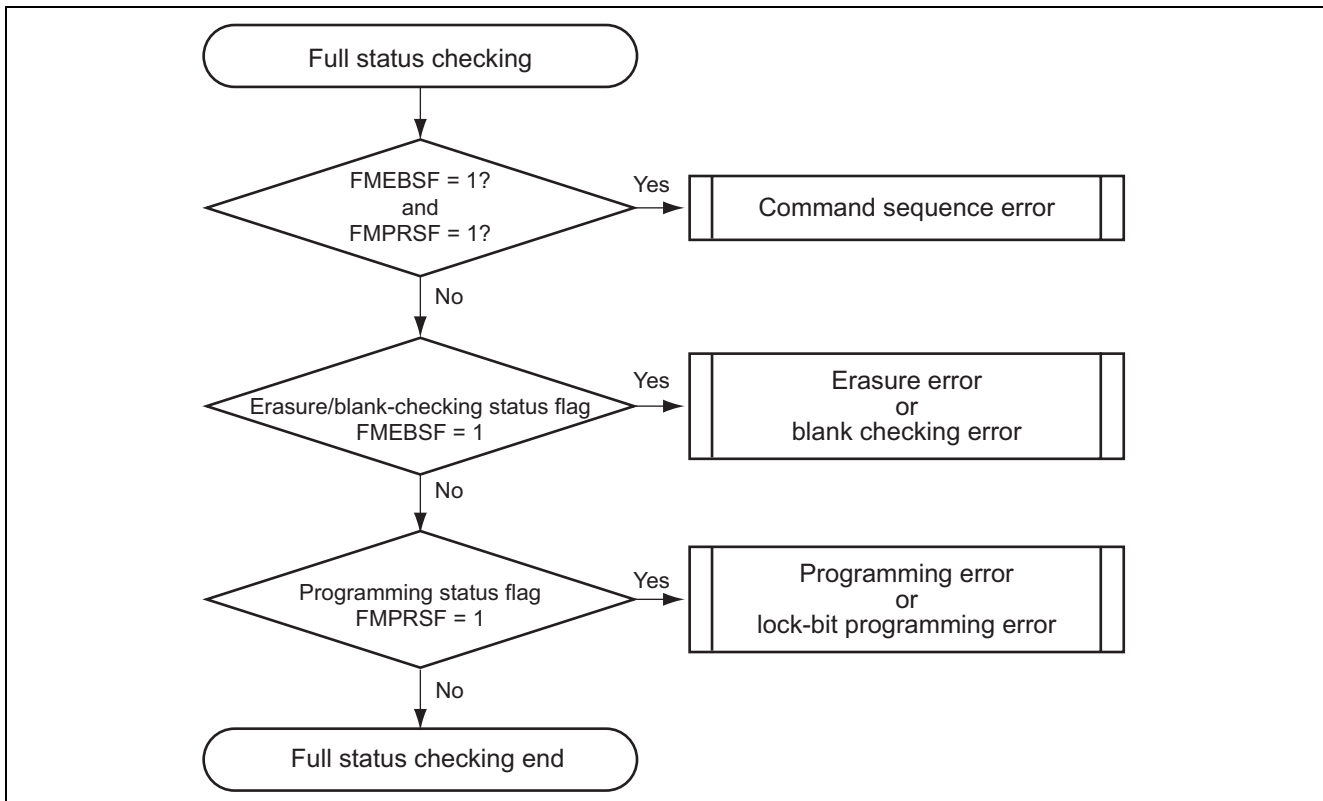
When any command (other than the read-array command, lock-bit reading command and status clearing command) is issued, full-status checking is performed to confirm whether or not there was an error.

When an error occurs, the FMPRSF and FMEBSF bits in FLMSTR are set to 1, indicating the occurrence of the relevant errors.

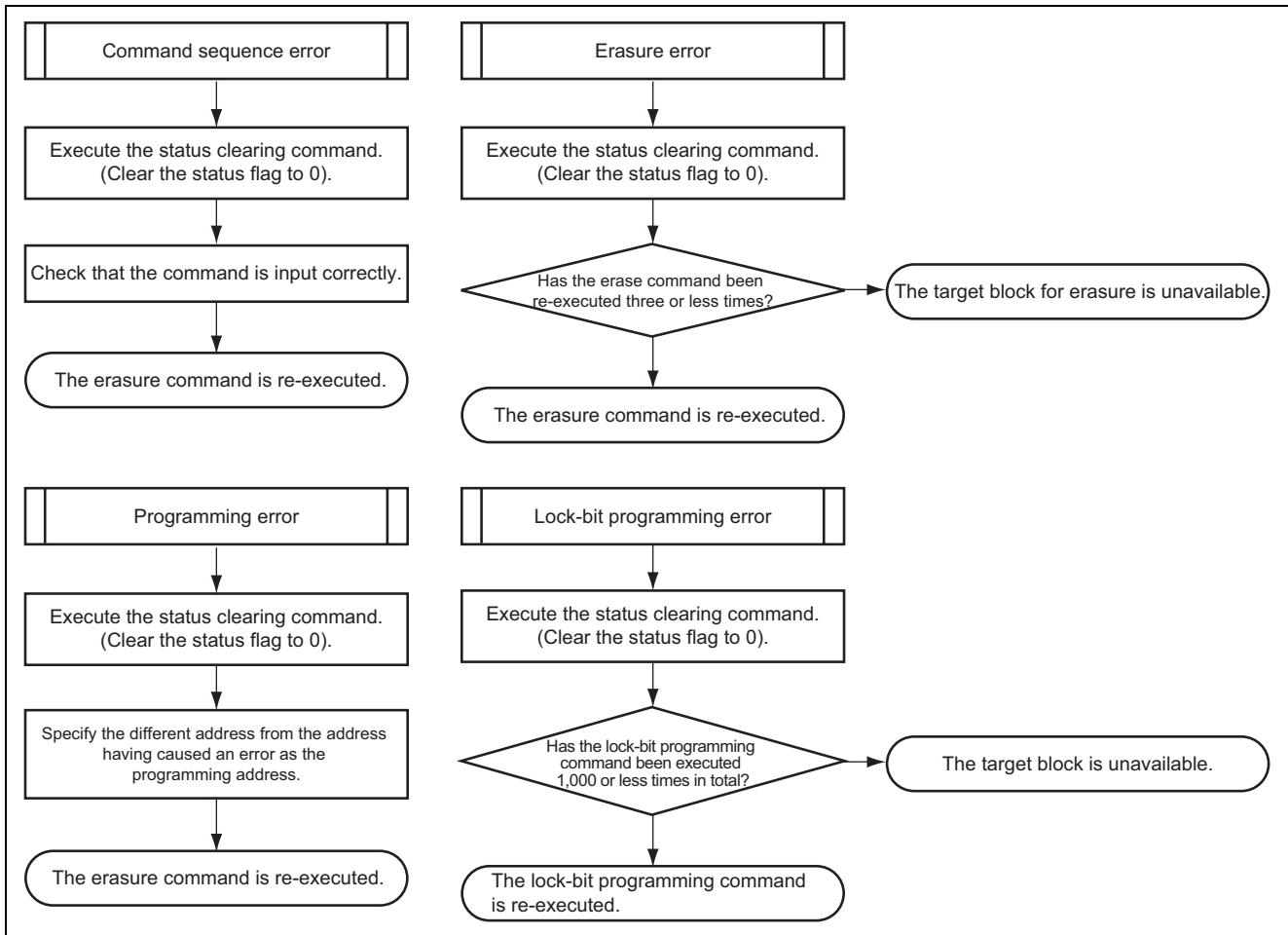
Table 4 shows the bit values in FLMSTR and the corresponding errors. Figure 11 shows the full status checking flowchart and figure 12 shows procedures for handling each error.

**Table 4 Bit Values in FLMSTR and Corresponding Errors**

Bit Values in FLMSTR		Error	Error Generation Conditions
FMEBSF	FMPSRF		
0	0	None (normal end)	—
0	1	Programming error	The programming command is executed and results in unsuccessful programming.
		Lock-bit programming error	The lock-bit programming command is executed and results in unsuccessful programming.
1	0	Erasure error	The erasure command is executed and results in unsuccessful erasure.
		Blank checking error	The blank checking command is executed and it is detected that the specified block is not blank.
1	1	Command sequence error	<ul style="list-style-type: none"> <li>• A command is not written correctly.</li> <li>• A data value other than H'D0 and H'FF is written in the last cycle of the command that consists of two command cycles.</li> <li>• The erasure command is input in erase-suspend mode.</li> <li>• The programming command is input for the suspended block in erase-suspend mode.</li> </ul>



**Figure 11 Full Status Checking Flowchart**



**Figure 12 Procedures for Handling Errors**

### **2.1.7 Protection**

Three modes are available to protect the flash memory against reading, programming, and erasing: software protection, lock-bit protection, and protection to restrict access in programmer mode and boot mode.

### **2.1.8 Software Protection**

Software commands can be disabled by clearing the FMCMDEN bit in the flash memory control register (FLMCR1) through software. In this state, software commands are not executed even if they are input.

Data-flash areas can be protected in block units by using the flash memory data-flash protect register (DFPR). Setting bits DFPR1 and DFPR0 in DFPR to 1 places all the data-flash areas in protect mode.

### **2.1.9 Lock-Bit Protection**

The programming/erasure commands can be disabled by programming the lock bits using the lock-bit programming command. In this state, the erasure/programming commands are not executed even if input. This prevents flash memory from being erroneously erased or programmed due to CPU runaway.

The protection function can be temporarily disabled by setting the FMLBD bit in FLMCR1 to 1.

To clear the lock bit, erase the specified block. Note that lock bits are unavailable in data-flash areas.

### 2.1.10 Usage Notes

(1) Prohibited Instruction

In EW0 mode, the following instruction cannot be used because it refers to the data in the flash memory area.

- TRAP

(2) Interrupts

Table 5 shows interrupt handling in CPU reprogramming mode.

**Table 5 Interrupt Handling in CPU Reprogramming Mode**

Mode	Command being Executed	On Reception of an Interrupt Request	On Generation of a Watchdog Timer Reset, LVD Reset, Software Reset, or Pin Reset
EW0	Erasure	Interrupts can be handled if interrupt vectors are located in RAM. For details, see the section on the interrupt vector offset register (VOFR) of H8S/20103, H8S/20203, H8S/20223 Group Hardware Manual.	Immediately after a reset is generated, a software command is forcibly terminated, and flash memory and LSI are reset. Because of the forced termination, it might be impossible to read correct values from the block or address for which the software command has been executed; execute erasure again after restarting and confirm that erasure is completed successfully. The watchdog timer does not stop even during command execution; initialize the timer periodically.
	Programming		
	Lock-bit programming		
	Blank checking		
EW1	Erasure (with the erase-suspend function not in use)	Erasure is given priority, keeping the interrupt request waiting. When erasure is completed, execution of the interrupt processing is started.	Immediately after a reset is generated, a software command is forcibly terminated, and flash memory and LSI are reset. Because of the forced termination, it might be impossible to read correct values from the block or address for which the software command has been executed; execute erasure again after restarting and confirm that erasure is completed successfully. Since the watchdog timer does not stop even during command execution, set the overflow time of the watchdog timer longer than the erasure/programming execution time.
	Erasure (with the erase-suspend function in use)	After the transition time to erase-suspend mode, erasure is suspended starting execution of the interrupt processing. When the interrupt processing is completed, setting the FMSPREQ bit in FLMCR2 to 0 resumes erasure.	
	Programming	A software command is given priority, keeping the interrupt request waiting. When the software command is completed, execution of the interrupt processing is started.	
	Lock-bit programming		
	Blank checking		

**(3) Method of Access**

When writing values to the protected bits indicated below, start by writing 0 to the bit and then write 1 to it or by writing 1 to the bit and then write 0 to it. Do not allow the generation of any interrupt or any access to other I/O registers between the two operations. For writing, always use the MOV instruction.

- a. Bits that are set to 1 by writing 0 and then 1 consecutively  
 FLMCR1: FMLBD and FMCMDEN bits  
 FLMCR2: FMISPE and FMSPEN bits
- b. Bits that are cleared to 0 by writing 1 and then 0 consecutively  
 DFPR: DFPR1 and DFPR0 bits

The example below is of code for use when the FMCMDEN and FMLBD bits in FLMCR1 are to be changed from 0 to 1.

```
MOV.B    @FLMCR1,R0L    :FLMCR1=H'04    R0L=H'04    R0H=H'xx
MOV.B    @FLMCR1,R0H    :FLMCR1=H'04    R0L=H'04    R0H=H'04
BSET     #0,R0H          :FLMCR1=H'04    R0L=H'04    R0H=H'05
BSET     #3,R0H          :FLMCR1=H'04    R0L=H'04    R0H=H'0D
MOV.B    R0L,@FLMCR1    :FLMCR1=H'04    R0L=H'04    R0H=H'0D
MOV.B    R0H,@FLMCR1    :FLMCR1=H'0D    R0L=H'04    R0H=H'0D
```

**(4) Reprogramming User ROM Area**

When it is necessary to reprogram the block containing the reprogramming-control program, use boot mode. This is because if the power supply voltage drops in EW0 mode while the block containing the reprogramming-control program is being reprogrammed, the reprogramming-control program cannot be correctly reprogrammed, and this might disable further reprogramming of the flash memory. Only proceed with overwriting of the programming-control program after securing ample stabilization time for the power supply.

**(5) Programming**

Do not program addresses that have already been programmed.

**(6) LSI Mode Transition**

During software command execution, do not cause a transition to standby mode or sleep mode.

**(7) Reset during Execution of Software Command in Flash Memory**

Do not apply a pin reset, LVD reset, watchdog timer reset or software reset during execution of the programming, lock-bit programming, blank-checking, and erasure commands. If applied, the currently executed command is forcibly terminated. In this case, execute the erasure command of the specified block again and confirm that erasure is completed successfully.

### 3. Principle of Operation

Figure 13 shows the principle of operation in this sample task. Data-flash memory is reprogrammed by means of hardware and software processing as shown in figure 13.

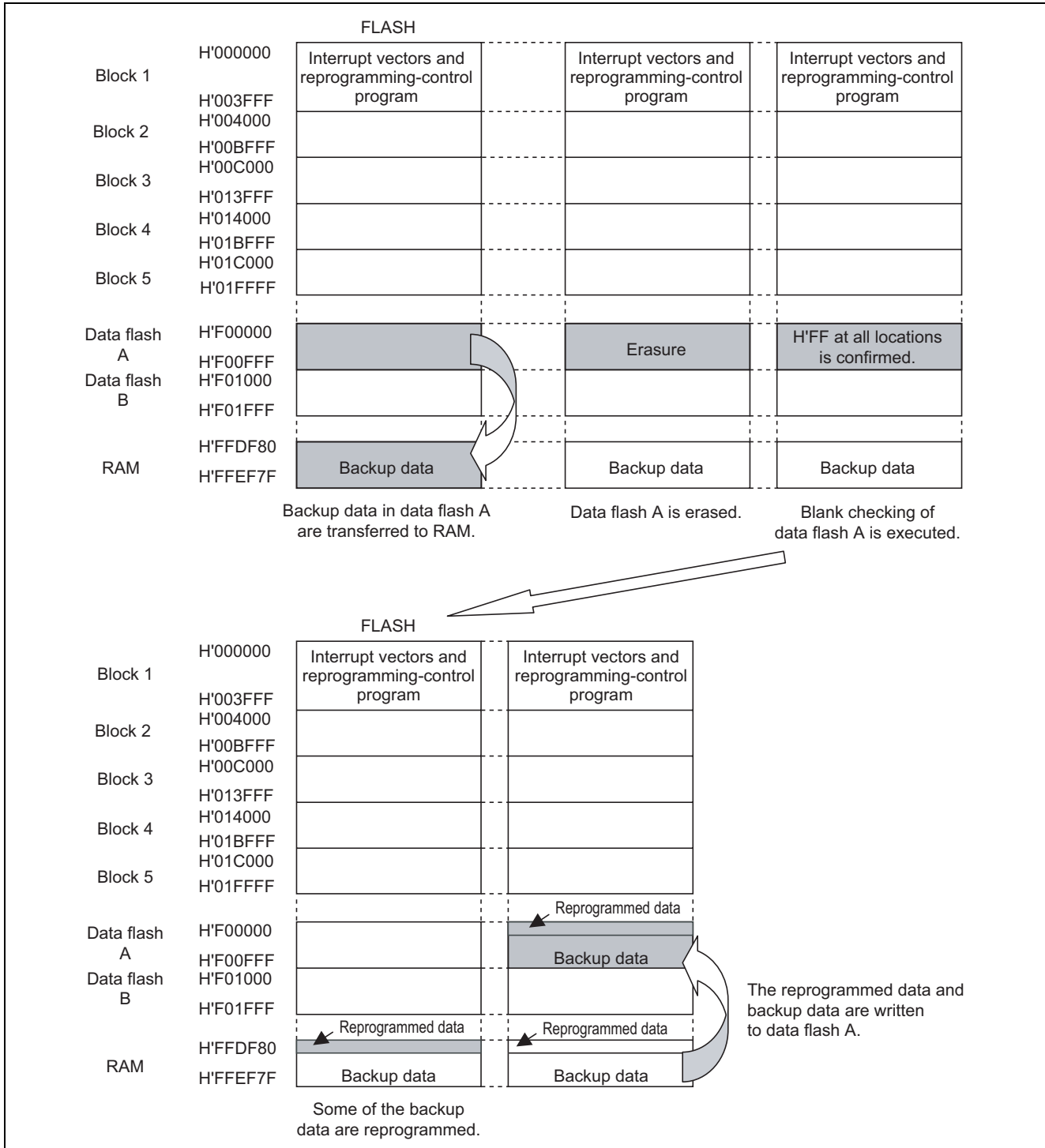


Figure 13 Principle of Operation in This Sample Task

## 4. Description of Software

### 4.1 Descriptions of Functions

The functions are listed and described in table 6.

**Table 6 Descriptions of Functions**

<b>Function Name</b>	Main Routine		
<b>Declaration</b>	void main(void)		
<b>Argument</b>	<b>Argument name</b>	<b>Type</b>	<b>Meaning</b>
	None	None	None
<b>Returned value</b>	<b>Type</b>	<b>Value</b>	<b>Meaning</b>
	None	None	None
<b>Description</b>	Calls most of the other functions.		

<b>Function Name</b>	System Initialization Routine		
<b>Declaration</b>	void h8s_sysinit(void)		
<b>Argument</b>	<b>Argument name</b>	<b>Type</b>	<b>Meaning</b>
	None	None	None
<b>Returned value</b>	<b>Type</b>	<b>Value</b>	<b>Meaning</b>
	None	None	None
<b>Description</b>	Makes settings for module standby, system clock and bus-master operating clock, and halts the WDT.		

<b>Function Name</b>	Erasure Routine		
<b>Declaration</b>	unsigned char ew1_erase (unsigned char *er_blk)		
<b>Argument</b>	<b>Argument name</b>	<b>Type</b>	<b>Meaning</b>
	er_blk	unsigned char *	Address setting to indicate the target block for erasure
<b>Returned value</b>	<b>Type</b>	<b>Value</b>	<b>Meaning</b>
	unsigned char	H'00: Normal end H'10: Erasure error H'18: Command sequence error	Result of executing an erasure command
<b>Description</b>	Erases data-flash area A in EW1 mode.		

<b>Function Name</b>	Blank Checking Routine		
<b>Declaration</b>	unsigned char ew1_blank_check (unsigned char *blank_blk)		
<b>Argument</b>	<b>Argument name</b>	<b>Type</b>	<b>Meaning</b>
	blank_blk	unsigned char *	Address setting to indicate the target block for blank checking
<b>Returned value</b>	<b>Type</b>	<b>Value</b>	<b>Meaning</b>
	unsigned char	H'00: Normal end H'10: Blank checking error H'18: Command sequence error	Result of executing a blank checking command
<b>Description</b>	Executes blank checking in data-flash area A in EW1 mode.		

<b>Function Name</b>	Programming Routine		
<b>Declaration</b>	unsigned char ew1_write(volatile unsigned char *wr_top, volatile unsigned char *wr_end, volatile unsigned char *wr_data)		
<b>Argument</b>	<b>Argument name</b>	<b>Type</b>	<b>Meaning</b>
	wr_top	volatile unsigned char *	First address for programming
	wr_end	volatile unsigned char *	End address for programming + 1
<b>Returned value</b>	<b>Type</b>	<b>Value</b>	<b>Meaning</b>
	unsigned char	H'00: Normal end H'08: Programming error H'18: Command sequence error	Result of executing a programming command
<b>Description</b>	Writes to data-flash area A in EW1 mode.		

<b>Function Name</b>	Full Status Checking Routine		
<b>Declaration</b>	unsigned char full_status_check(unsigned char *addr)		
<b>Argument</b>	<b>Argument name</b>	<b>Type</b>	<b>Meaning</b>
	addr	unsigned char *	Setting of the target address for full status checking
<b>Returned value</b>	<b>Type</b>	<b>Value</b>	<b>Meaning</b>
	unsigned char	H'00: Normal end H'08: Programming error or lock-bit programming error H'10: Erasure error or blank checking error H'18: Command sequence error	Result of executing full status checking
<b>Description</b>	Checks full status.		

## 4.2 Description of Internal Registers

Table 7 gives descriptions of how internal registers are used in this sample task.

**Table 7 Description of Internal Registers**

Register Name	Symbol	Function	Address	Setting	
PMRJ	PMRJ[1:0]	The OSC1 and OSC2 functions are selected for pins PJ0/OSC1 and PJ1/OSC2.	H'FF000C	B'11	
FLMCR1	FMWUS	Setting to select reprogramming by the CPU to be initiated by byte-length instructions.	H'FF0660	0	
	FMEWMOD	EW1 mode is selected.		1	
	FMCMDEN* <sup>1*2*3*4</sup>	Software commands for flash memory are enabled.		1	
DFPR	DFPR1* <sup>5*6</sup>	E/W of data-flash B is disabled	H'FF0662	1	
	DFPR0* <sup>5*6</sup>	E/W of data-flash A is enabled.		0	
FLMSTR	FMEBSF* <sup>7*8</sup>	Erase/blank checking status flag 0: Normal end 1: End with an error [Setting conditions] <ul style="list-style-type: none"> <li>The erase command is executed and results in unsuccessful erase.</li> <li>The blank-checking command is executed and it is detected that the specified block is not blank.</li> </ul> [Clearing condition] <ul style="list-style-type: none"> <li>The status clearing command is issued.</li> </ul>	H'FF0663	—	
		FMPRSF* <sup>7*8</sup>		Programming status flag 0: Normal end 1: End with an error [Setting conditions] <ul style="list-style-type: none"> <li>The programming command is executed and results in unsuccessful programming.</li> <li>The lock-bit programming command is executed and results in unsuccessful programming.</li> </ul> [Clearing condition] <ul style="list-style-type: none"> <li>The status clearing command is issued.</li> </ul>	—
		FMRDY		Flash memory ready/busy status flag 0: Busy (programming or erase in progress) 1: Ready [Setting condition] <ul style="list-style-type: none"> <li>Flash memory is not being programmed or erased.</li> </ul> [Clearing condition] <ul style="list-style-type: none"> <li>Flash memory is being programmed or erased.</li> </ul>	—
SYSCCR	PHIHSEL	$\phi$ high clock source is set to $\phi$ osc.	H'FF06D0	1	
LPCR1	PSCSTP	PSC divider is operating.	H'FF06D1	0	
	PHIBSEL	$\phi$ base clock source is set to $\phi$ high.		1	
LPCR2	PHI[2:0]	System clock $\phi$ is set to $\phi$ base.	H'FF06D2	B'000	
LPCR3	PHIS[2:0]	Bus-master operating clock $\phi$ s is set to $\phi$ .	H'FF06D3	B'000	
OSCCSR		$\phi$ osc oscillation settling time is set.	H'FF06D5	H'0E	

Register Name	Symbol	Function	Address	Setting
TMWD		Clock input to the WDT is prohibited.	H'FFFF99	H'F7
TCSRWD		Writing to the TMWD register is enabled.	H'FFFF9A	H'A3
MSTCR1	MSTWDT	WDT is released from the module standby mode.	H'FFFFDC	0

- Notes:
1. When setting the bit to 1, first clear the bit to 0 and then immediately set the bit to 1; do not allow any interrupt to be generated between these operations.
  2. The bit is cleared to 0 when the FMRDY bit changes from 0 to 1.
  3. Set the FMEWMOD bit and then set the FMCMDEN bit to 1.
  4. When setting the FMCMDEN bit to 1 while the FMEWMOD bit is 0, be sure to execute the program in the RAM.
  5. When setting the bit to 0, first set the bit to 1 and then immediately set the bit to 0; do not allow any interrupt to be generated between these operations.
  6. The DFPR bits are set to 1 when the FMCMDEN bit changes from 0 to 1.
  7. The bit cannot be set to 1 through software.
  8. The bit is cleared to 0 when the status clearing command is executed.

### 4.3 RAM Usage

Table 8 gives a description of RAM usage in this sample task.

**Table 8 RAM Usage**

Label Name	Functions	Memory	Module Name
—	Data-flash area A for back up (H'FFDF80 to H'FFEF7F)	4 KB	—

#### 4.4 Descriptions of Definitions in Use

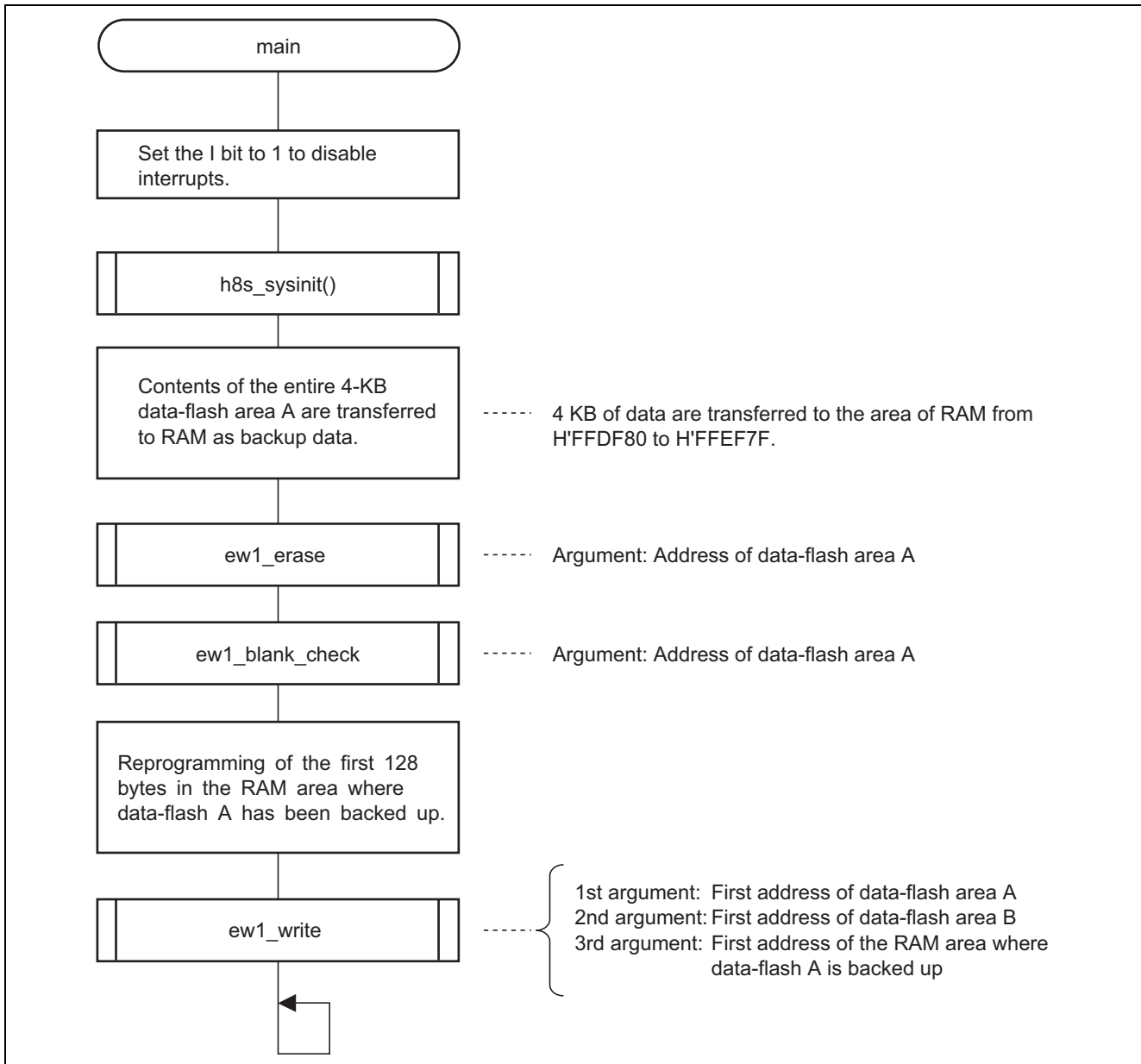
Table 9 gives descriptions of the definitions used in this sample task.

**Table 9 Descriptions of Definitions in Use**

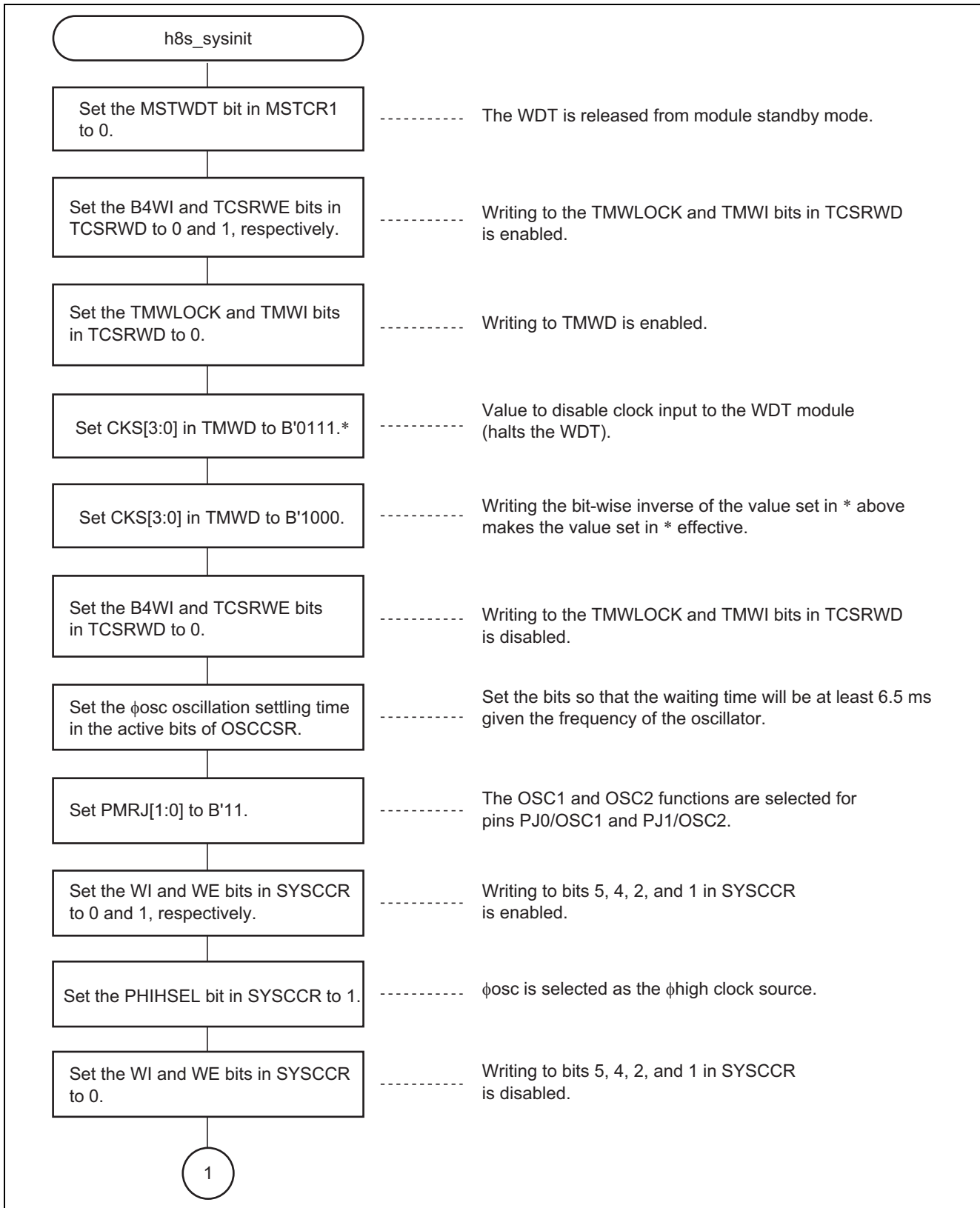
<b>Label Name</b>	<b>Description</b>	<b>Constant</b>
FULL_STATUS	Mask value for use in full status checking of FLMSTR	H'28
COMMAND_SEQUENCE_ERR	Value corresponding to a command sequence error; for use in full status checking of FLMSTR	H'28
ERASE_BLANK_ERR	Value corresponding to an erasure error or blank checking error; for use in full status checking of FLMSTR	H'20
PRG_LOCKBIT_ERR	Value corresponding to a programming error or lock-bit programming error; for use in full status checking of FLMSTR	H'08
NO_ERR	Value corresponding to normal completion: for use in full status checking of FLMSTR	H'00
WRITE_SIZE	Size of the portion of data-flash A to be reprogrammed	H'80
BACK_UP_AREA	First address in the back-up RAM area of data-flash A	H'FFDF80
FLASH_BLK_A	First address of data-flash area (erasure block) A	H'F00000
FLASH_BLK_B	First address of data-flash area (erasure block) B	H'F01000
FLASH_BLK_B_END	End address of data-flash area (erasure block) B	H'F01FFF

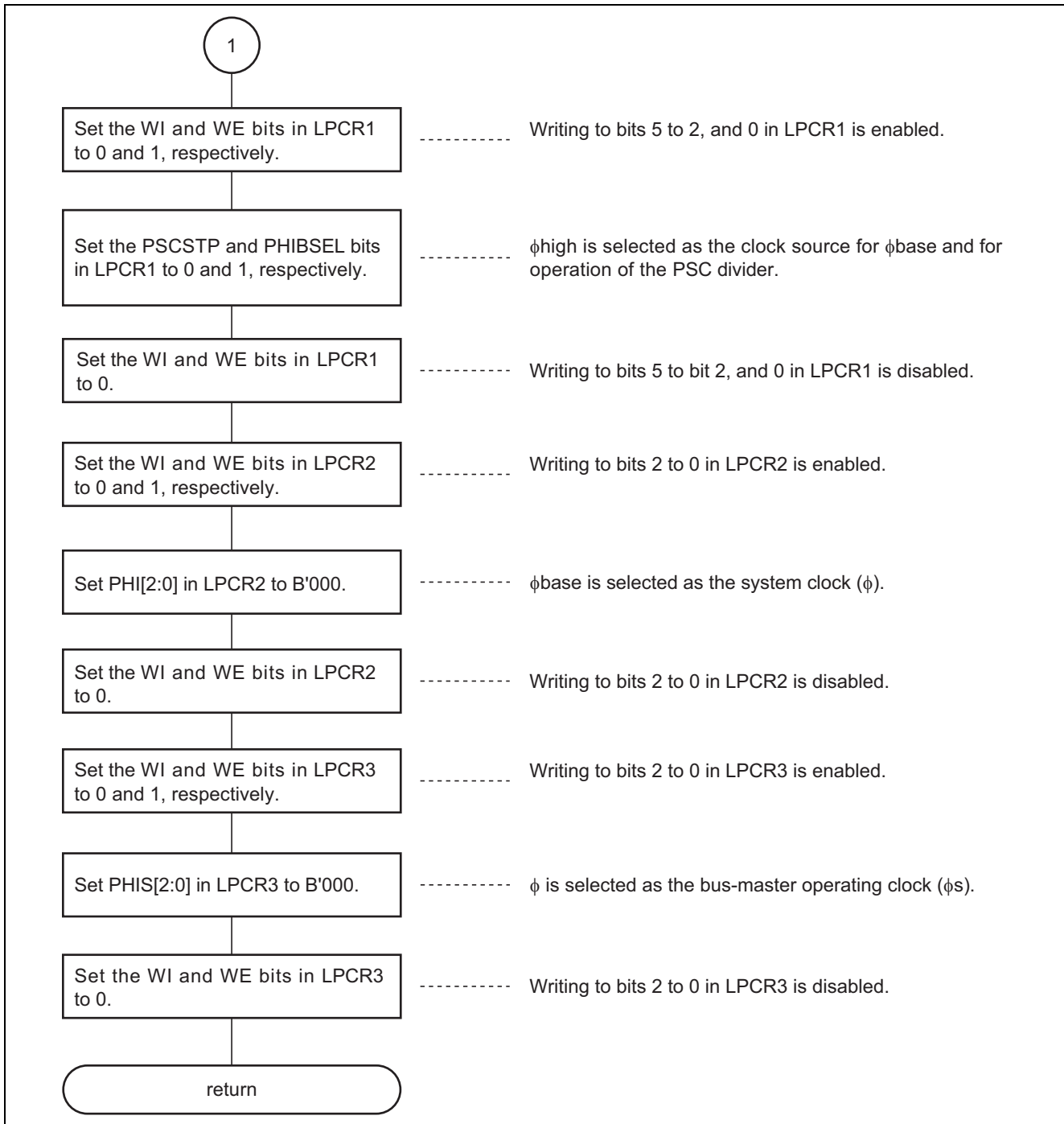
5. Flowcharts

5.1 Main Routine

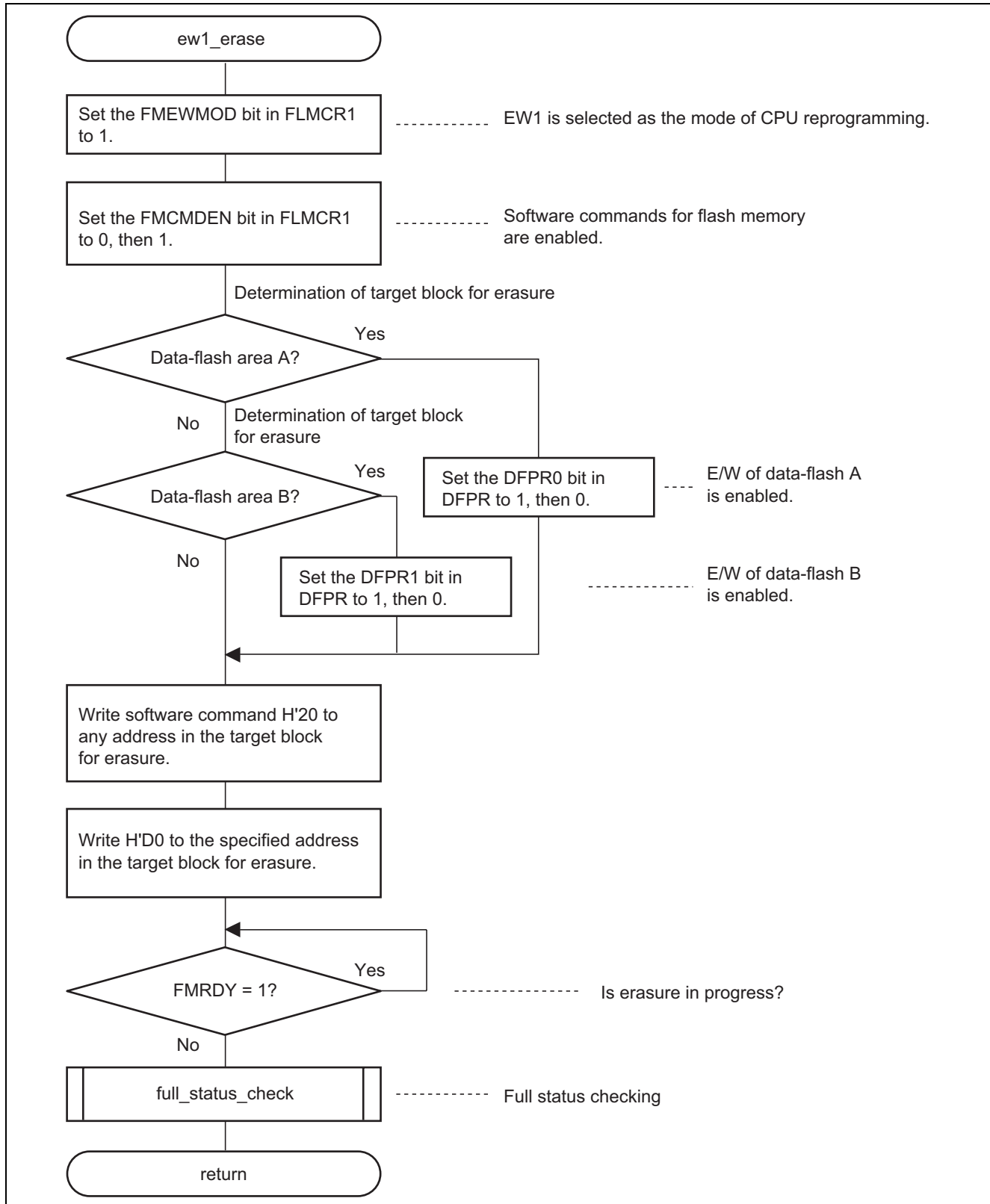


5.2 System Initialization Routine

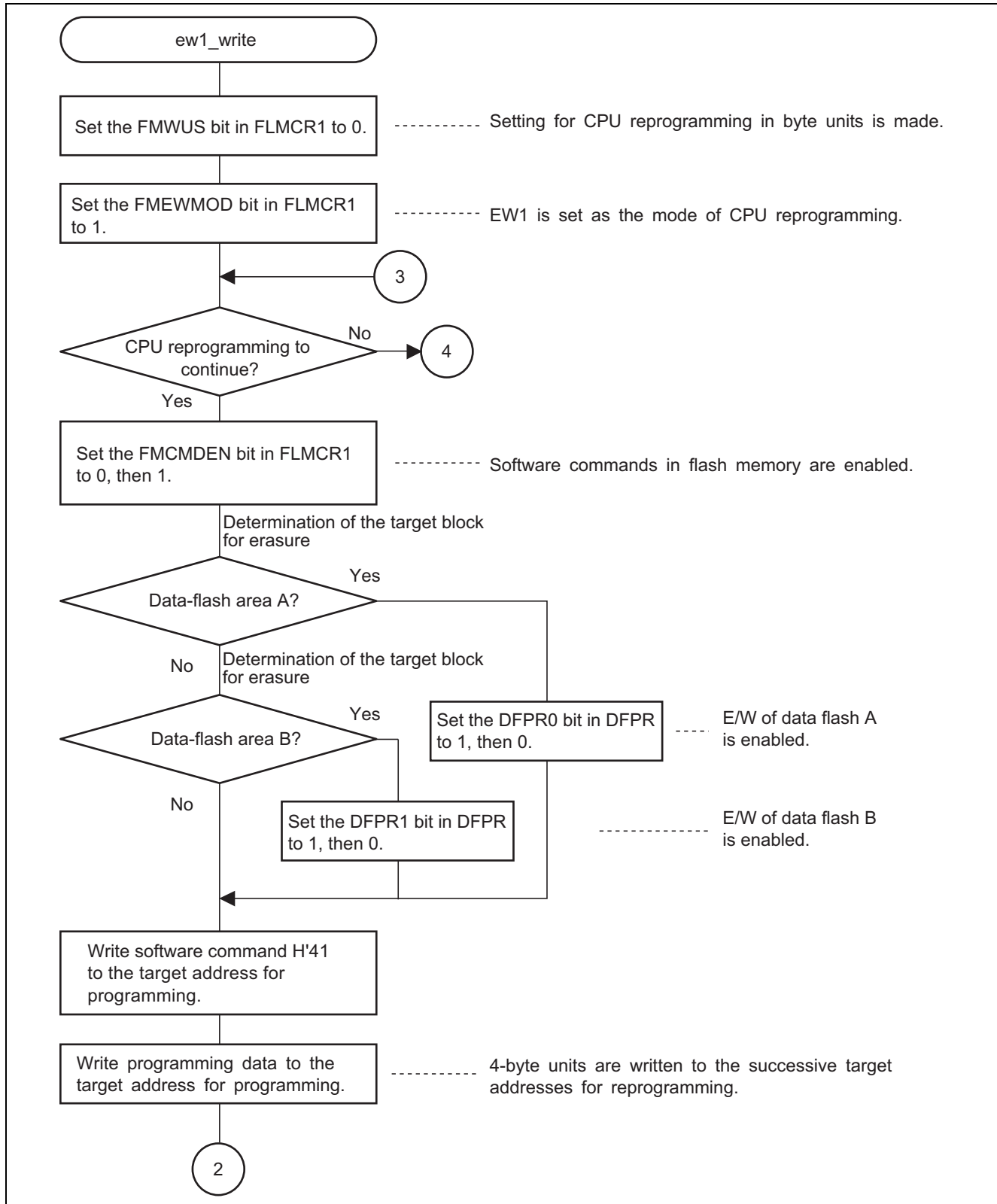


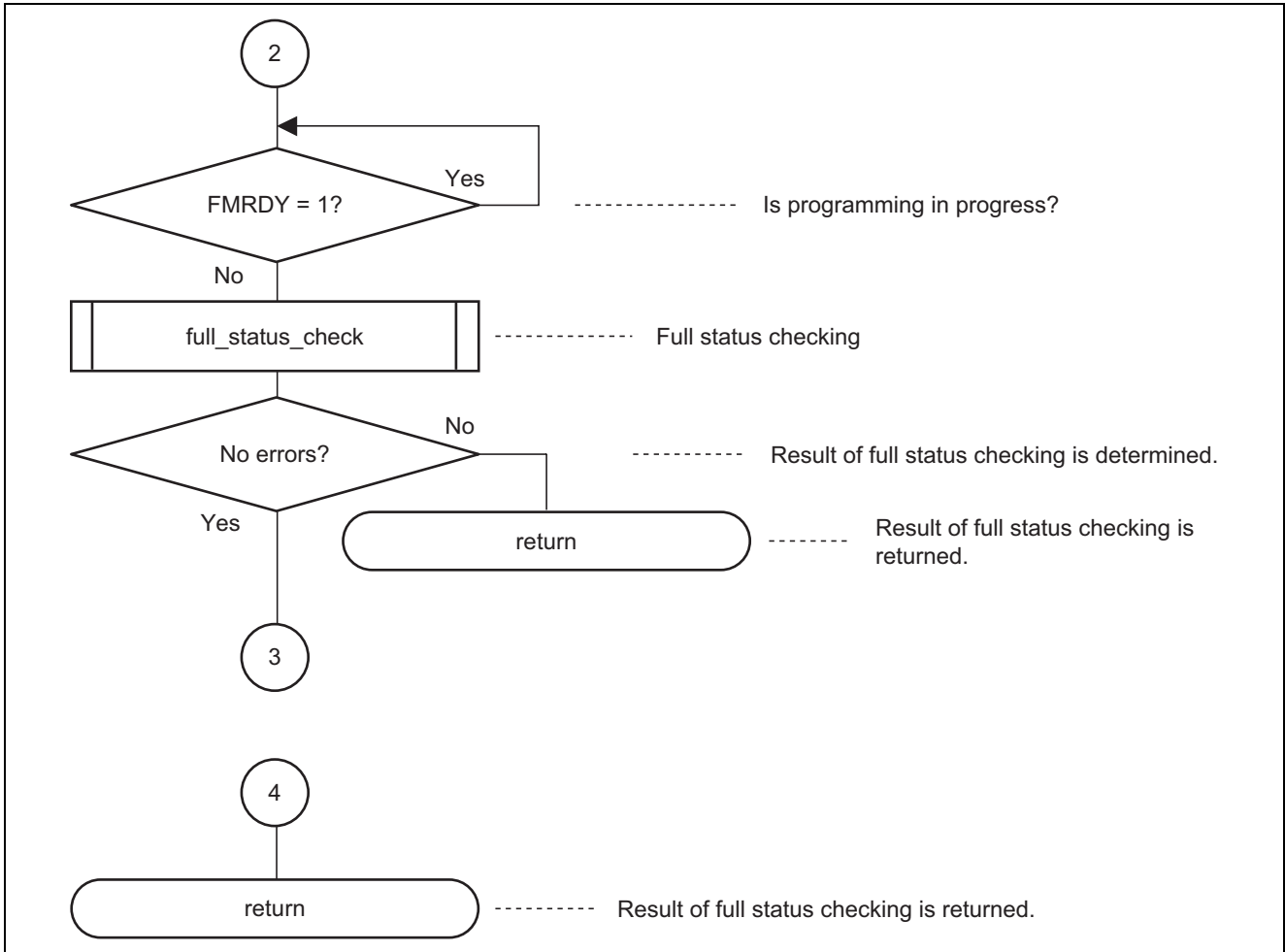


5.3 Erasure Routine

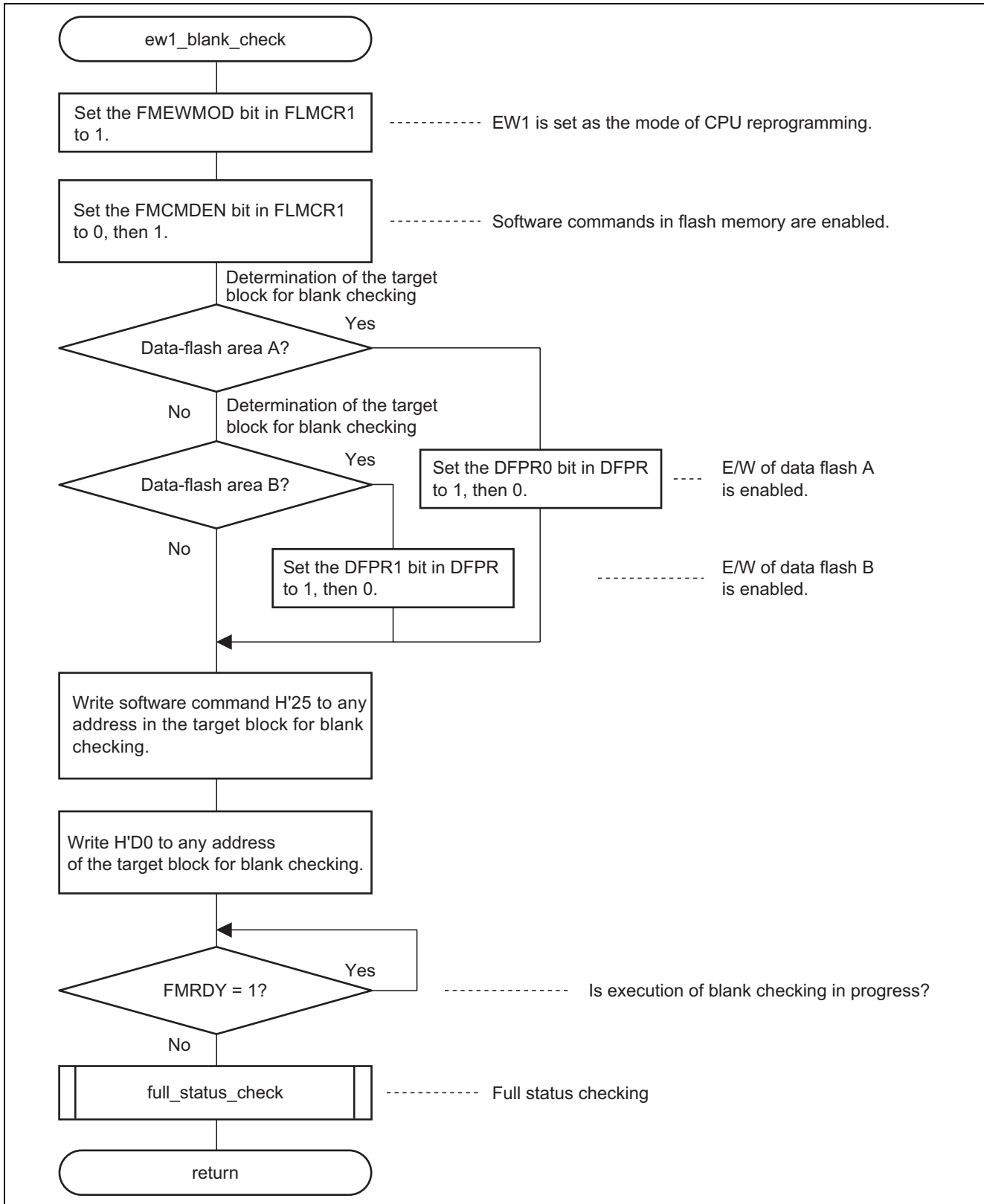


5.4 Programming Routine

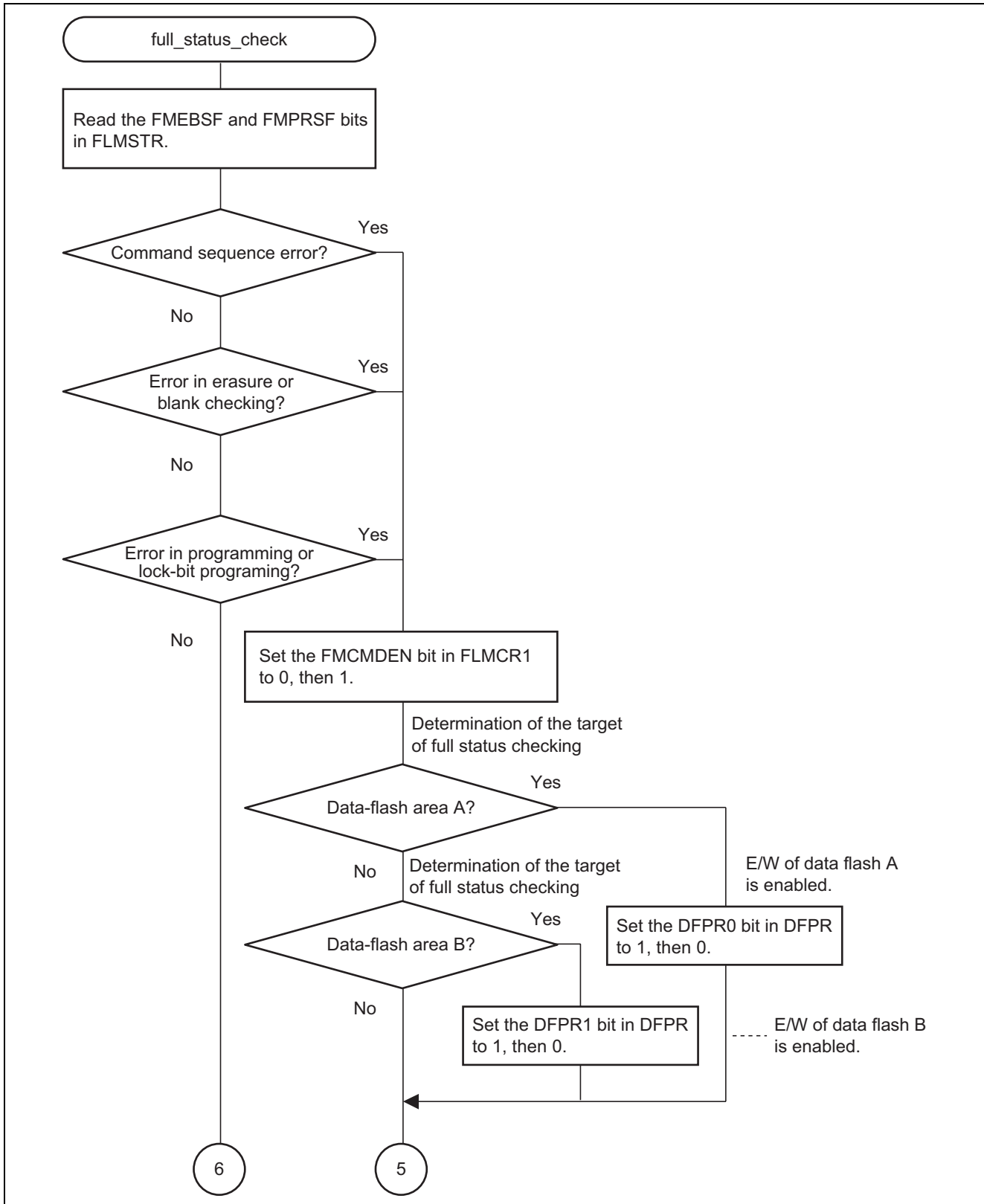


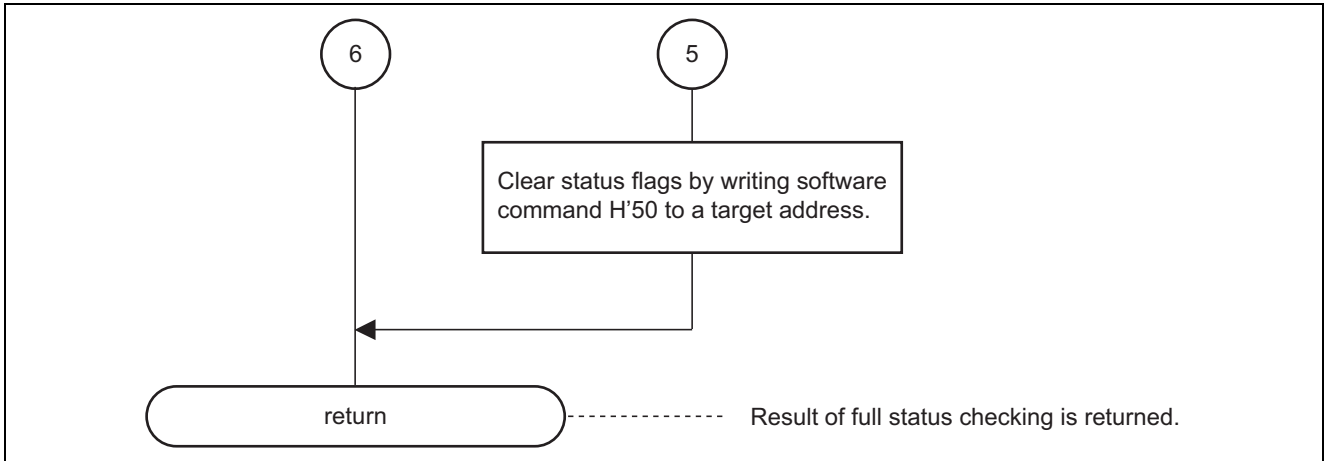


5.5 Blank Checking Routine



5.6 Full Status Checking Routine





## 6. Program Listing

```

/*****
/* H8S/2000 Tiny Series -H8S/20203-
/* Application Note
/*
/* data flash read and write
/*
/*
/* Function: data flash read and write (EW1 mode)
/*
/*
/*
/* External Clock: 20MHz
/* Internal Clock: 20MHz
/*****
#include <machine.h>
#include "iodefine.h"

#define FULL_STATUS          0x28    /* mask FLMSTR of FMEBSF,FMPSRF */
#define COMMAND_SEQUENCE_ERR 0x28    /* FMEBSF=1, FMPSRF=1 */
#define ERASE_BLANK_ERR      0x20    /* FMEBSF=1, FMPSRF=0 */
#define PRG_LOCKBIT_ERR      0x08    /* FMEBSF=0, FMPSRF=1 */
#define NO_ERR                0x00    /* FMEBSF=0, FMPSRF=0 */

#define WRITE_SIZE           0x80    /* data size written to data flash A */
#define BACK_UP_AREA        (volatile unsigned char *)0xFFDF80

/* Data Flash block area */
#define FLASH_BLK_A          (volatile unsigned char *)0xF0000
#define FLASH_BLK_B          (volatile unsigned char *)0xF01000
#define FLASH_BLK_B_END      (volatile unsigned char *)0xF01FFF

/*****
/* Declaration of function prototype
/*****
void main(void);
unsigned char ewl_write( volatile unsigned char *wr_top,
                        volatile unsigned char *wr_end, volatile unsigned char *wr_data );
unsigned char ewl_erase( unsigned char *er_blk );
unsigned char ewl_blank_check( unsigned char *blank_blk );
unsigned char full_status_check( unsigned char *adrs );
void h8s_sysinit(void);

```

```

/*****/
/* Name      : main          */
/* Parameters : None         */
/* Returns   : None         */
/* Description : User main   */
/*****/
void main(void)
{
    unsigned char ii, chk;
    volatile unsigned char *df_p, *ram_p;

    set_ccr(0x80);          /* set CCR-Ibit */

    h8s_sysinit();         /* initialize system */

    /* back up data of data flash A(4KB) */
    for ( df_p=FLASH_BLK_A, ram_p=BACK_UP_AREA; df_p<FLASH_BLK_B; df_p++, ram_p++ ){
        (*ram_p) = (*df_p);
    }

    /* EW1 erase of data flash A */
    chk = ewl_erase( FLASH_BLK_A );

    /* blank check data flash A */
    chk = ewl_blank_check( FLASH_BLK_A );

    /* create write data of data flash */
    for ( ii=0, ram_p=BACK_UP_AREA; ram_p<(BACK_UP_AREA+WRITE_SIZE); ii++, ram_p++ ){
        (*ram_p) = ii;
    }

    /* EW1 write of data flash */
    chk = ewl_write( FLASH_BLK_A, FLASH_BLK_B, BACK_UP_AREA );

    while(1);
}

```

```

/*****/
/* Name      : ewl_write          */
/* Parameters : (wr_top)address of write top      */
/*           : (wr_end)address of write end      */
/* Returns   : write result          */
/* Description : data flash write program        */
/*           : of EW1 mode            */
/*****/
unsigned char ewl_write( volatile unsigned char *wr_top,
    volatile unsigned char *wr_end, volatile unsigned char *wr_data )
{
    volatile unsigned char *ptr;
    unsigned char result;
    unsigned char ii;

    FLASH.FLMCR1.BIT.FMWUS = 0;                /* byte write */

    FLASH.FLMCR1.BIT.FMEWMOD = 1;              /* select EW1 mode */

    for( ptr=wr_top; ptr<wr_end; ptr+=4 ){
        FLASH.FLMCR1.BIT.FMCM DEN = 0;
        FLASH.FLMCR1.BIT.FMCM DEN = 1;          /* flash memory software command enable */

        /* Data Flash A ? */
        if ( (FLASH_BLK_A <= ptr) && (ptr < FLASH_BLK_B) ){
            FLASH.DFPR.BIT.DFPRO = 1;          /* E/W enable of Data Flash A */
            FLASH.DFPR.BIT.DFPRO = 0;          /* E/W enable of Data Flash A */
        }
        /* Data Flash B ? */
        else if ( (FLASH_BLK_B <= ptr) && (ptr <= FLASH_BLK_B_END) ){
            FLASH.DFPR.BIT.DFPR1 = 1;          /* E/W enable of Data Flash B */
            FLASH.DFPR.BIT.DFPR1 = 0;          /* E/W enable of Data Flash B */
        }

        (*ptr) = 0x41;                          /* software command 0x41 */

        /* 4byte write */
        for( ii=0; ii<4; ii++, wr_data++){
            (*ptr) = (*wr_data);
        }

        while( FLASH.FLMSTR.BIT.FMRDY != 1 );    /* write complete ? */

        result = full_status_check(ptr);         /* full status check */

        if ( result != NO_ERR ){
            return;
        }
    }

    return (result);
}

```

```

/*****/
/* Name      : ewl_erase          */
/* Parameters : (er_blk)address of erase BLOCK */
/* Returns   : erase result       */
/* Description : data flash erase program      */
/*           : of EW1 mode        */
/*****/
unsigned char ewl_erase( unsigned char *er_blk )
{
    unsigned char result;

    FLASH.FLMCR1.BIT.FMEWMOD = 1;          /* select EW1 mode */

    FLASH.FLMCR1.BIT.FMCMDEN = 0;
    FLASH.FLMCR1.BIT.FMCMDEN = 1;          /* flash memory software command enable */

    /* Data Flash A ? */
    if ( (FLASH_BLK_A <= er_blk) && (er_blk < FLASH_BLK_B) ){
        FLASH.DFPR.BIT.DFPR0 = 1;          /* E/W enable of Data Flash A */
        FLASH.DFPR.BIT.DFPR0 = 0;          /* E/W enable of Data Flash A */
    }

    /* Data Flash B ? */
    else if ( (FLASH_BLK_B <= er_blk) && (er_blk <= FLASH_BLK_B_END) ){
        FLASH.DFPR.BIT.DFPR1 = 1;          /* E/W enable of Data Flash B */
        FLASH.DFPR.BIT.DFPR1 = 0;          /* E/W enable of Data Flash B */
    }

    (*er_blk) = 0x20;                       /* write software command H'20 */
    (*er_blk) = 0xD0;                       /* write software command H'D0 */

    while( FLASH.FLMSTR.BIT.FMRDY != 1 );    /* erase complete ? */

    result = full_status_check(er_blk);      /* full status check */

    return (result);
}

```

```

/*****/
/* Name      : ewl_blank_check          */
/* Parameters : (blk_top)address of blank check */
/* Returns   : blank check result       */
/* Description : blank check program     */
/*****/
unsigned char ewl_blank_check( unsigned char *blank_blk )
{
    unsigned char result;

    FLASH.FLMCR1.BIT.FMEWMOD = 1;          /* select EW1 mode */

    FLASH.FLMCR1.BIT.FMCM DEN = 0;
    FLASH.FLMCR1.BIT.FMCM DEN = 1;          /* flash memory software command enable */

    /* Data Flash A ? */
    if ( (FLASH_BLK_A <= blank_blk) && (blank_blk < FLASH_BLK_B) ){
        FLASH.DFPR.BIT.DFPR0 = 1;          /* E/W enable of Data Flash A */
        FLASH.DFPR.BIT.DFPR0 = 0;          /* E/W enable of Data Flash A */
    }
    /* Data Flash B ? */
    else if ( (FLASH_BLK_B <= blank_blk) && (blank_blk <= FLASH_BLK_B_END) ){
        FLASH.DFPR.BIT.DFPR1 = 1;          /* E/W enable of Data Flash B */
        FLASH.DFPR.BIT.DFPR1 = 0;          /* E/W enable of Data Flash B */
    }

    (*blank_blk) = 0x25;                    /* blank check software command H'25 */
    (*blank_blk) = 0xD0;                    /* blank check software command H'D0 */

    while( FLASH.FLMSTR.BIT.FMRDY != 1 );  /* blank check complete ? */

    result = full_status_check(blank_blk);  /* full status check */

    return (result);
}

```

```

/*****/
/* Name      : full_status_check          */
/* Parameters : (addr)E/W block address   */
/* Returns    : full status check result  */
/* Description: full status check        */
/*****/
unsigned char full_status_check( unsigned char *addr )
{
    unsigned char tmp_flmstr;

    /* Full status check */
    tmp_flmstr = FLASH.FLMSTR.BYTE & FULL_STATUS; /* read FLMSTR */

    switch ( tmp_flmstr ){
        case COMMAND_SEQUENCE_ERR: /* command sequence error */
        case ERASE_BLANK_ERR: /* erase or blank check error */
        case PRG_LOCKBIT_ERR: /* program or lock bit program error */

        /* error processing */
            FLASH.FLMCR1.BIT.FMCMDEN = 0;
            FLASH.FLMCR1.BIT.FMCMDEN = 1; /* flash memory software command enable */

        /* Data Flash A ? */
        if ( (FLASH_BLK_A <= addr) && (addr < FLASH_BLK_B) ){
            FLASH.DFPR.BIT.DFPRO = 1; /* E/W enable of Data Flash A */
            FLASH.DFPR.BIT.DFPRO = 0; /* E/W enable of Data Flash A */
        }

        /* Data Flash B ? */
        else if ( (FLASH_BLK_B <= addr) && (addr <= FLASH_BLK_B_END) ){
            FLASH.DFPR.BIT.DFPR1 = 1; /* E/W enable of Data Flash B */
            FLASH.DFPR.BIT.DFPR1 = 0; /* E/W enable of Data Flash B */
        }

        (*addr) = 0x50; /* Clear status command */

        break;

    default : /* No error */

        break;
    }

    return (tmp_flmstr);
}

```

```

/*****/
/* Name      : h8s_sysinit          */
/* Parameters : None                */
/* Returns   : None                */
/* Description : initialize H8S/20203 */
/*****/
void h8s_sysinit(void)
{
    MSTCR1.BIT.MSTWDT = 0;          /* WDT module standby off */

    /* stop WDT */
    WDT.TCSRWD.BYTE = 0x97;        /* write enable TMWLOCK, TMWI */
    WDT.TCSRWD.BYTE = 0xA3;        /* write enable TMWD */
    WDT.TMWD.BYTE = 0xF7;          /* Not select clock source */
    WDT.TMWD.BYTE = 0xF8;          /* write bit inversion */
    WDT.TCSRWD.BYTE = 0x87;        /* write disable TMWLOCK, TMWI */

    CPG.OSCCSR.BYTE = 0x0E;        /* wait over 6.5ms, Phi_osc=20MHz */
    PMRJ.BYTE = 0x03;             /* select OSC1,OSC2 */

    CPG.SYSSCCR.BYTE = (CPG.SYSSCCR.BYTE & 0x7F) | 0x40; /* WI=0, WE=1 */
    CPG.SYSSCCR.BYTE = 0x60;        /* high=Phi_osc, Phi_low=Phi_loco */
    CPG.SYSSCCR.BYTE = CPG.SYSSCCR.BYTE & 0x3F; /* WI=0, WE=0 */

    CPG.LPCR1.BYTE = (CPG.LPCR1.BYTE & 0x7F) | 0x40; /* WI=0, WE=1 */
    CPG.LPCR1.BYTE = 0x41;          /* PSC on, Phi_base=Phi_high */
    CPG.LPCR1.BYTE = CPG.LPCR1.BYTE & 0x3F; /* WI=0, WE=0 */

    CPG.LPCR2.BYTE = (CPG.LPCR2.BYTE & 0x7F) | 0x40; /* WI=0, WE=1 */
    CPG.LPCR2.BYTE = 0x40;          /* select system clock */
    CPG.LPCR2.BYTE = CPG.LPCR2.BYTE & 0x3F; /* WI=0, WE=0 */

    CPG.LPCR3.BYTE = (CPG.LPCR3.BYTE & 0x7F) | 0x40; /* WI=0, WE=1 */
    CPG.LPCR3.BYTE = 0x40;          /* select clock of bus master */
    CPG.LPCR3.BYTE = CPG.LPCR3.BYTE & 0x3F; /* WI=0, WE=0 */
}

```

## 6.1 Designation of Link Addresses

Section Name	Address
PRresetPRG, PIntPRG	H'000400
P, C\$DSEC, C\$BSEC, D	H'000800
B, R	H'FFEF80
S	H'FFFD80

## Website and Support

Renesas Technology Website

<http://www.renesas.com/>

Inquiries

<http://www.renesas.com/inquiry>

[csc@renesas.com](mailto:csc@renesas.com)

## Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Oct.31.08	—	First edition issued

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